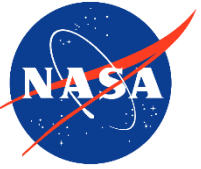
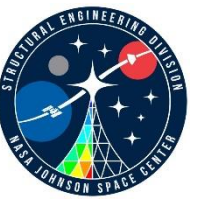


Thermochromic Variable Emittance Coatings for Spacecraft Thermal Control

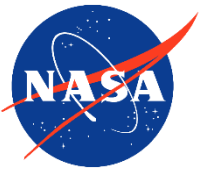
Sydney Taylor, PhD
NASA Lyndon B. Johnson Space Center
Houston, TX



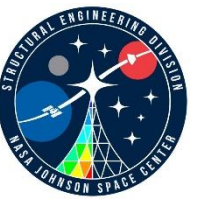
Outline



- Personal Background
- Research Introduction and Motivation
- Designing a Variable Emittance Coating
- Fabricating and Characterizing a Variable Emittance Coating
- Thermal Vacuum Experiments and Feasibility Studies
- On-going Projects at NASA
- Thermal Technology Gaps Overview



Background



2009
2010
2011
2012
2013
2014
2015
2016
2017
2018
2019
2020
2021



B.S. AAE '13

GE Combustion Intern Spring '12
GE PLM Intern Summer '13



Ph.D. Aerospace Engineering '20

NASA Space Tech Research Fellow '16-'20
Pathways Intern Spring and Summer '20
Full-Time at NASA January '21

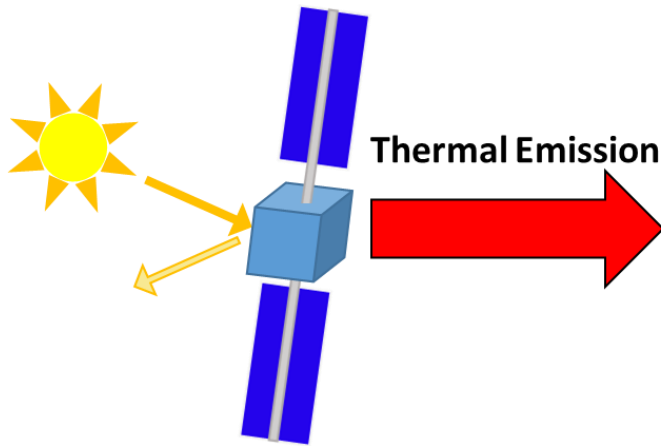




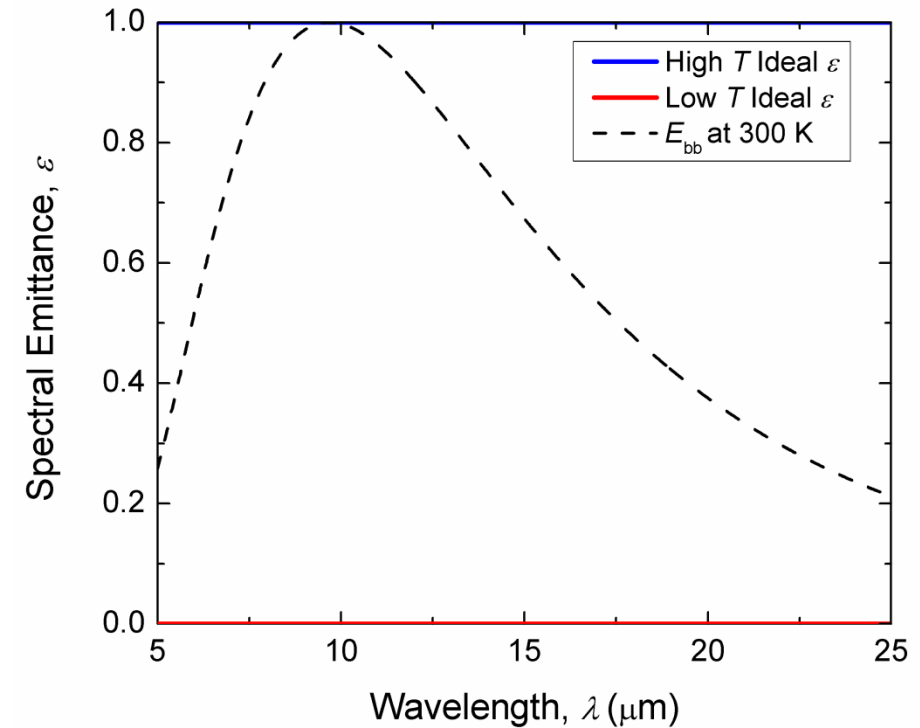
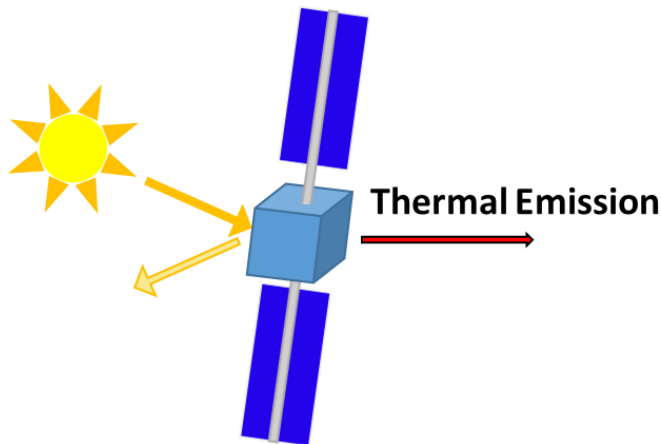
Research Introduction and Motivation

Variable Emittance Coatings

High Temperature (Cooling)



Low Temperature (Heating)



Ideal Broadband Emittance

- High Temp: $\epsilon \approx 1$
- Low Temp: $\epsilon \approx 0$

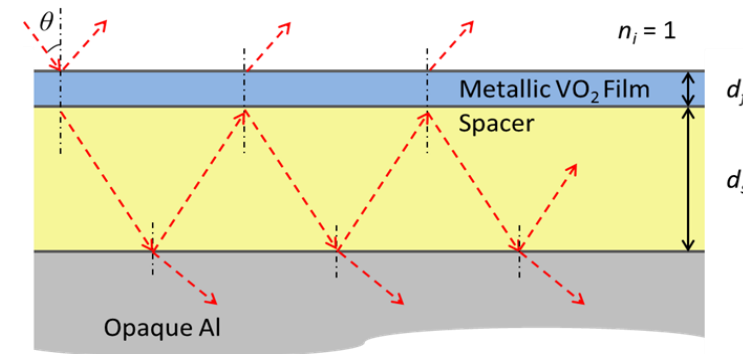
Thermochromic Coating Design

What is VO₂?

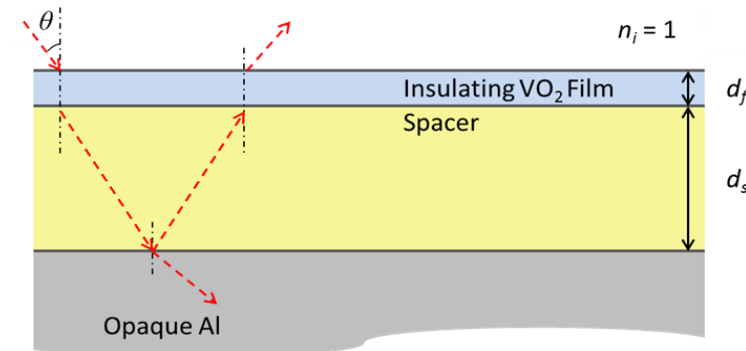
VO₂ is a thermochromic insulator to metal phase transition material

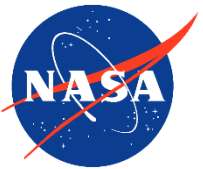
- At **high temperatures**, the Fabry-Perot resonance cavity is formed, leading to an emission enhancement near resonance wavelength of $\lambda = 10 \mu\text{m}$
- At **low temperatures**, the structure becomes highly reflective due to the high IR transmittance of the VO₂ and spacer material

Metallic VO₂ ($T > 345 \text{ K}$)

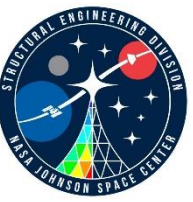
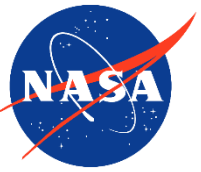


Insulating VO₂ ($T < 341 \text{ K}$)





Designing a Variable Emittance Coating



Modeling Properties of VO₂

Dielectric Functions (ϵ):

Insulator ($T = 341$ K):

$$\epsilon_d(\omega) = \epsilon_\infty + \sum_{j=1}^N S_j \frac{\omega_j^2}{\omega_j^2 - i\gamma_j\omega - \omega^2}$$

Metallic ($T > 345$ K):

$$\epsilon_m = \frac{-\omega_p^2 \epsilon_\infty}{\omega^2 - i\omega\omega_c}$$

In Transition ($341 \text{ K} < T < 345 \text{ K}$):

$$f \frac{\epsilon_m - \epsilon_{\text{eff}}}{\epsilon_{\text{eff}} + q(\epsilon_m - \epsilon_{\text{eff}})} + (1-f) \frac{\epsilon_d - \epsilon_{\text{eff}}}{\epsilon_{\text{eff}} + q(\epsilon_d - \epsilon_{\text{eff}})} = 0$$

Where:

ϵ_∞ = High frequency dielectric constant

S_j = Phonon strength

ω_j = Phonon frequency

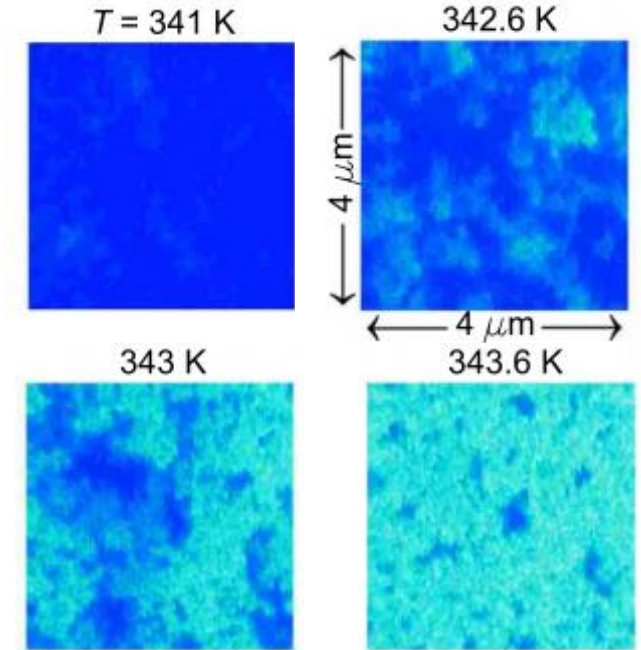
ω_p = Plasma frequency

ω_c = Collision frequency

q = Depolarization factor

f = Filling Fraction

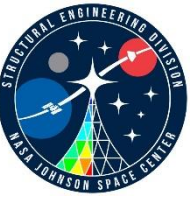
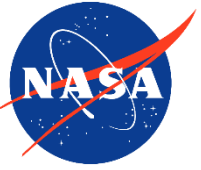
γ_j = Damping Coefficient



T (K)	f	q_0	q_E
341	0	--	--
342	0.18	0.2	0.6
342.6	0.31	0.33	0.34
343	0.48	0.45	0.1
343.6	0.7	0.5	0
345	1.0	--	--

Qazilbash et al., Phys. Rev. B, **79**, 075107 (2007)

Barker et al., Phys. Rev. Lett., **17**, 1286 (1966)



Uniaxial Transfer Matrix Method

Indirect Calculation of Emittance:

$$\varepsilon'_\lambda = 1 - R'_\lambda - T'_\lambda$$

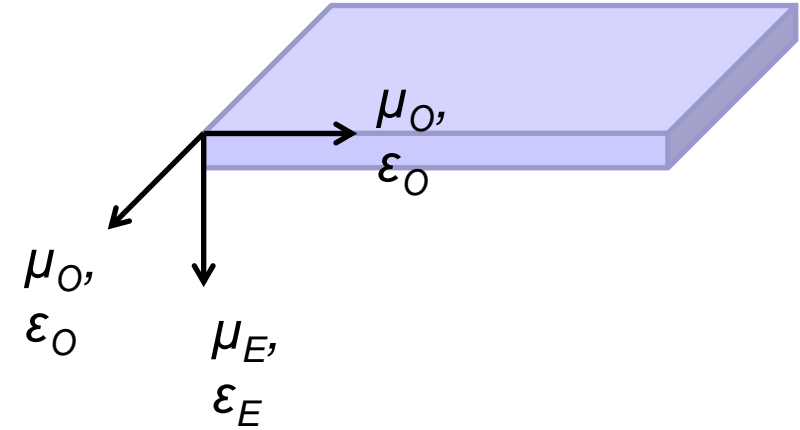
Transmittance:

$$T'^{p}_\lambda = \frac{\text{Re}(k^p_{z,N} / \varepsilon_{N,O})}{\text{Re}(k^p_{z,1} / \varepsilon_{1,O})} \left| \frac{1}{M_{11}} \right|^2$$

$$T'^{s}_\lambda = \frac{\text{Re}(k^s_{z,N} / \mu_{N,O})}{\text{Re}(k^s_{z,1} / \mu_{1,O})} \left| \frac{1}{M_{11}} \right|^2$$

Reflectance:

$$R'_\lambda = rr^* = \left| \frac{M_{21}}{M_{11}} \right|^2$$

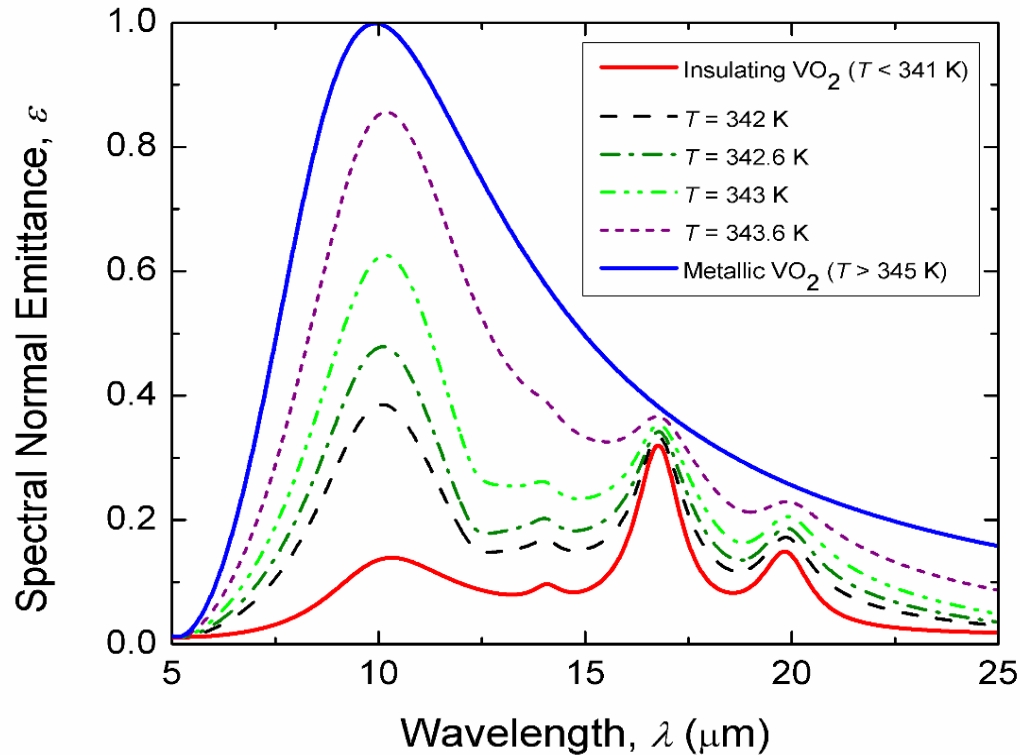


Z-direction Wavevector:

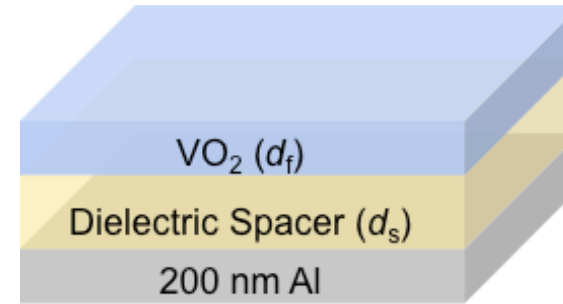
$$k^s_{z,i} = \sqrt{k_0^2 \varepsilon_{iO} \mu_{iO} - \mu_{iO} k_x^2 / \mu_{iE}}$$

$$k^p_{z,i} = \sqrt{k_0^2 \varepsilon_{iO} \mu_{iO} - \varepsilon_{iO} k_x^2 / \varepsilon_{iE}}$$

Thermochromics Design



Temperature-dependent emittance via the VO_2 phase transition



- VO_2 Thickness:

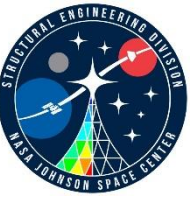
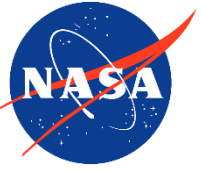
$$d_f = 25 \text{ nm}$$

- Spacer Thickness:

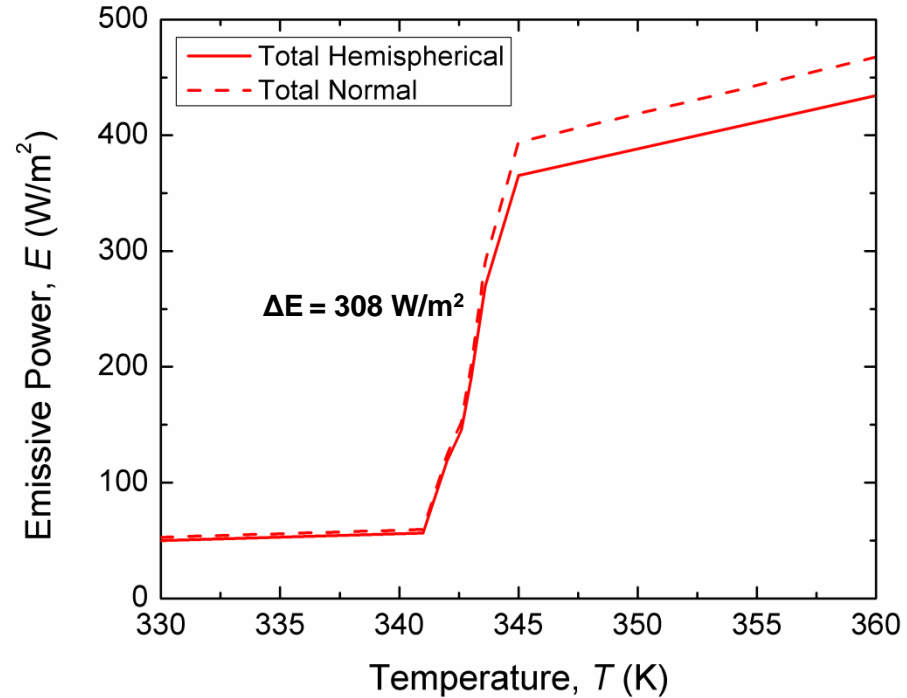
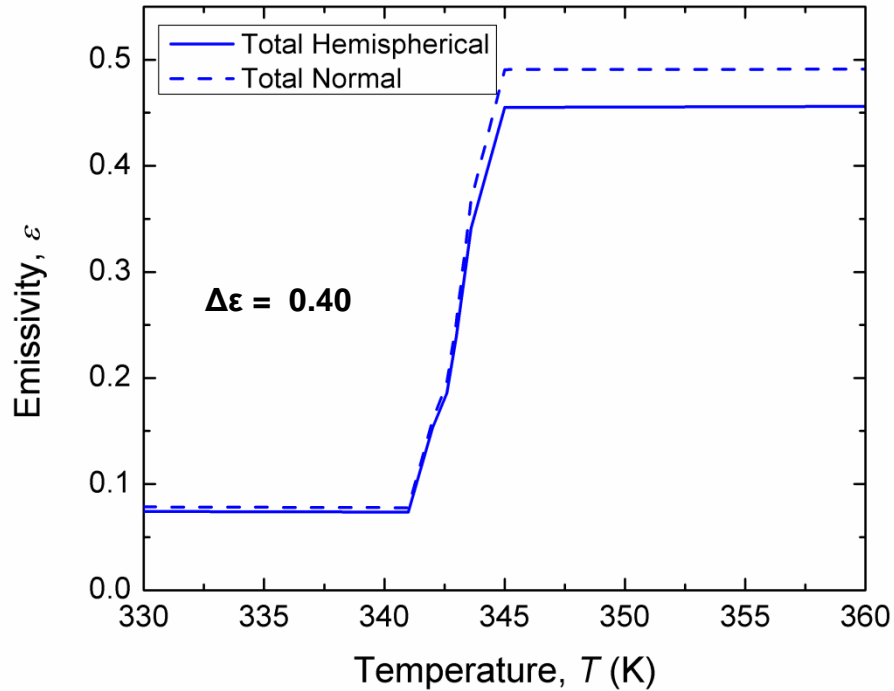
$$d_s = \lambda_{\text{peak}} / 4n \approx 730 \text{ nm}$$

$$\text{where } \lambda_{\text{peak}} = 10 \text{ } \mu\text{m}$$

$$n = 3.4$$



Variable Emitter Total Emittance

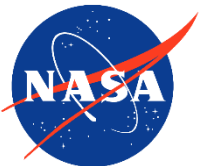


Total Hemispherical Emmissivity:

$$\varepsilon = \frac{2 \int_{0.3\mu\text{m}}^{40\mu\text{m}} E_{bb} \int_0^{\pi/2} \varepsilon'_\lambda(T, \lambda, \theta) \cos \theta \sin \theta d\theta d\lambda}{\sigma T^4}$$

Total Hemispherical Emissive Power:

$$E_{\text{hem}} = \varepsilon \sigma T^4$$

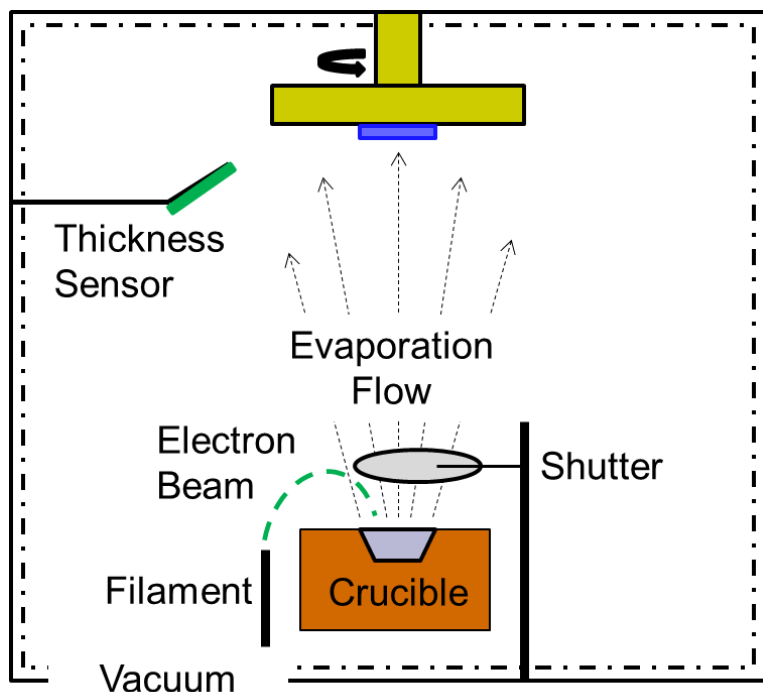


Fabricating and Characterizing a Variable Emittance Coating

VO₂ Thin Film Fabrication

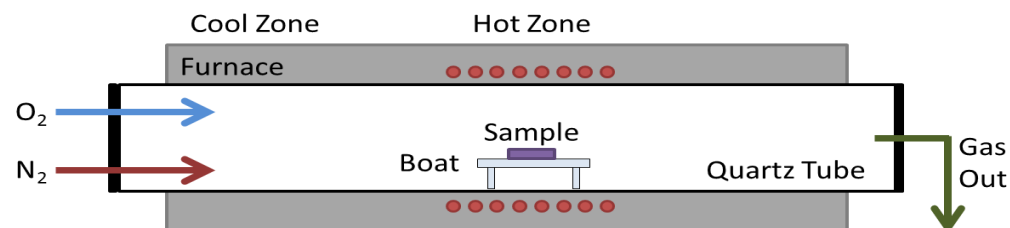
Electron Beam Evaporation:

- Deposit V thin film



Tube Furnace Oxidation:

- Oxidize V thin film to VO₂



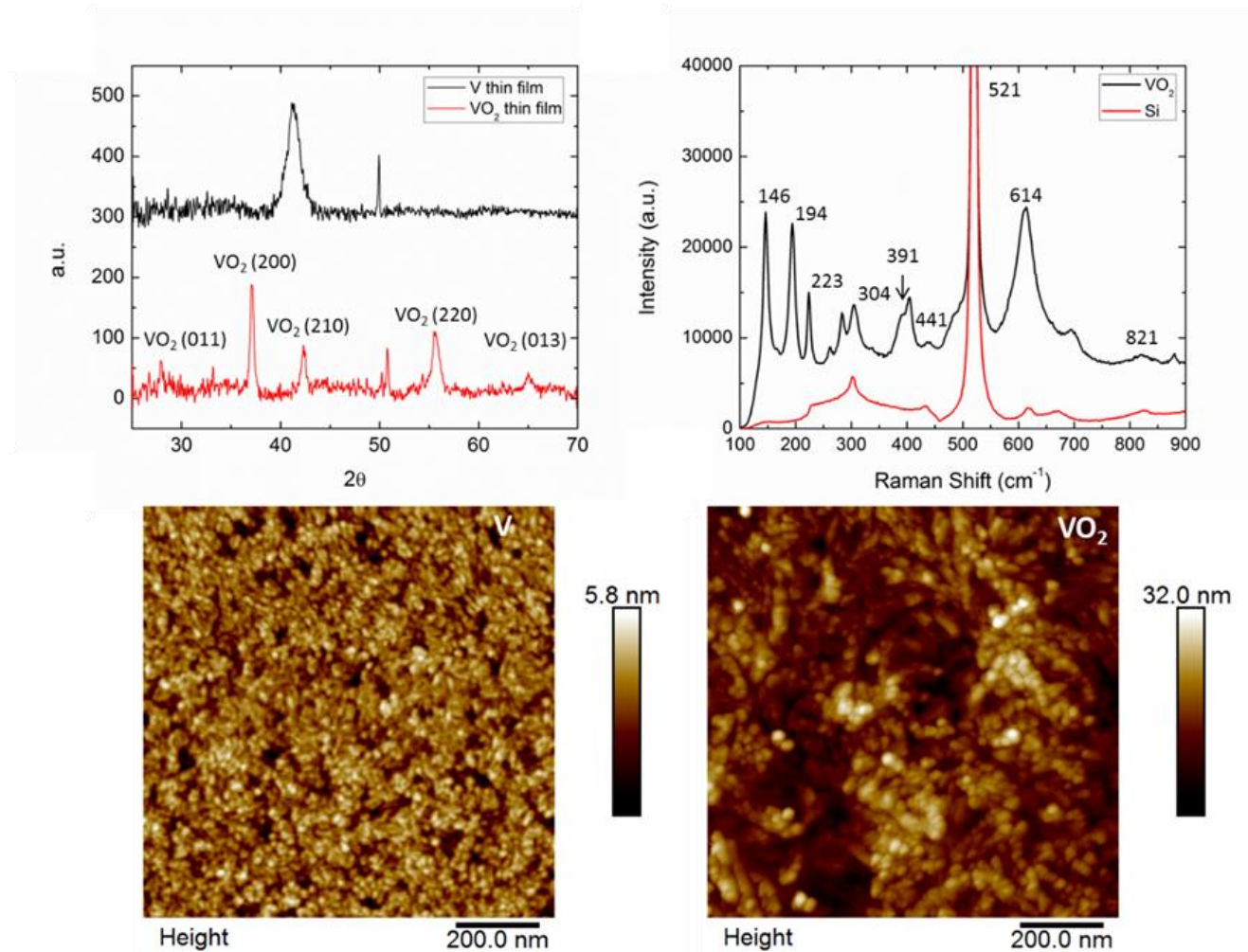
What furnace conditions do we need?

- Temperature
- Furnace Time
- O₂ flow rate
- N₂ flow rate



Conducted series of parametric studies to determine optimal conditions

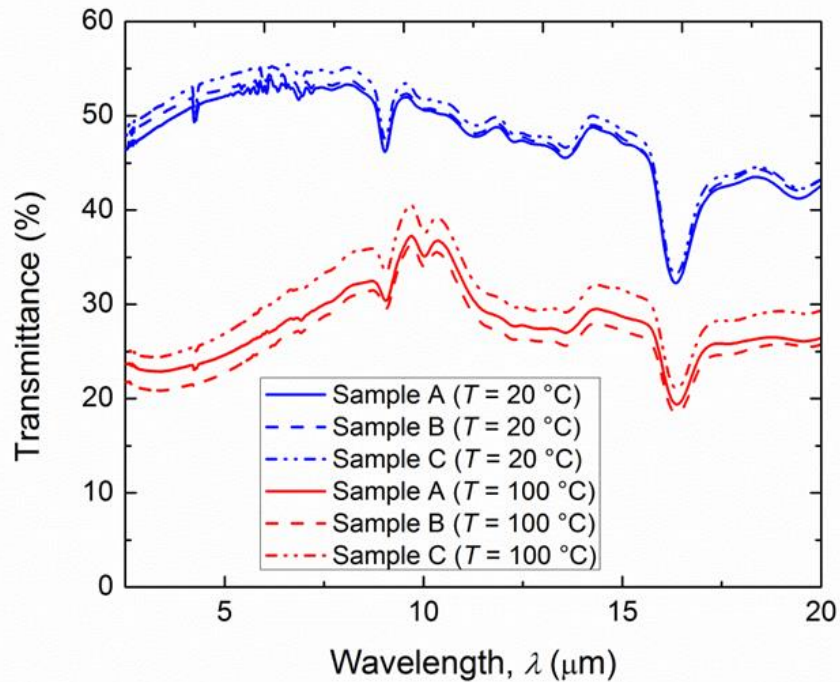
VO₂ Thin Film Characterization



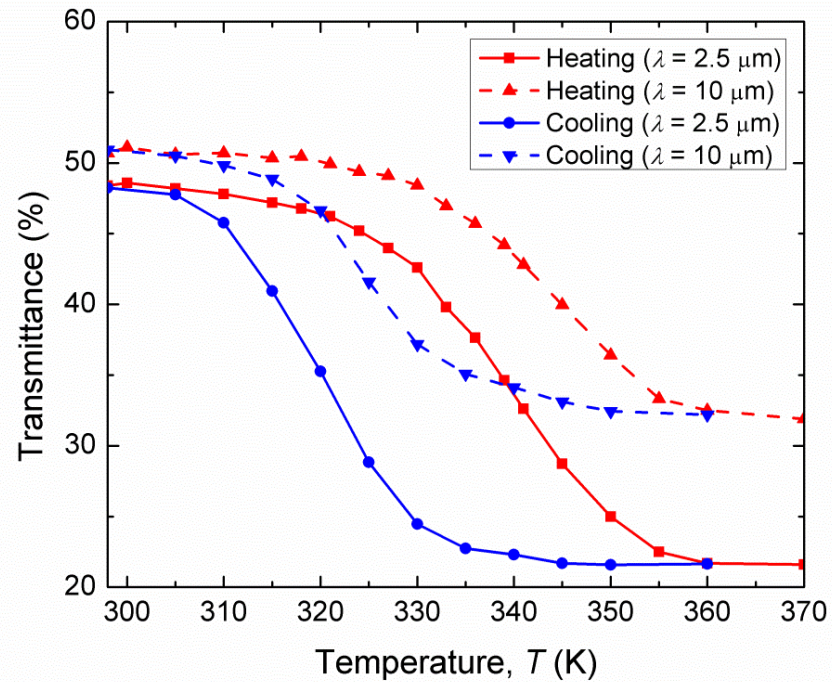
- XRD pattern and Raman spectrum consistent with published results for VO₂ thin films
- Roughness of V and VO₂ is 0.79 nm and 4.79 nm respectively

VO₂ Thin Film IR Characterization

Transmittance of VO₂ Films



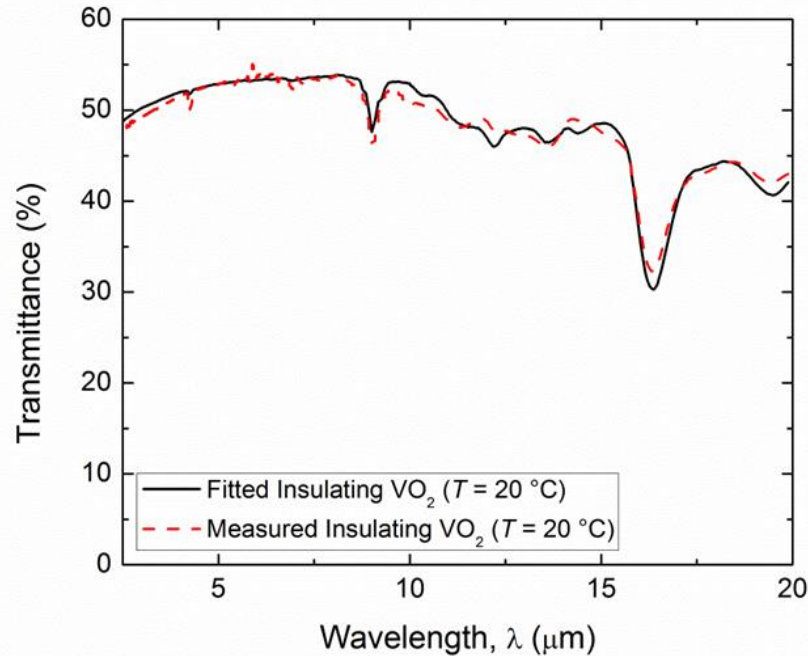
Heating and Cooling Curves



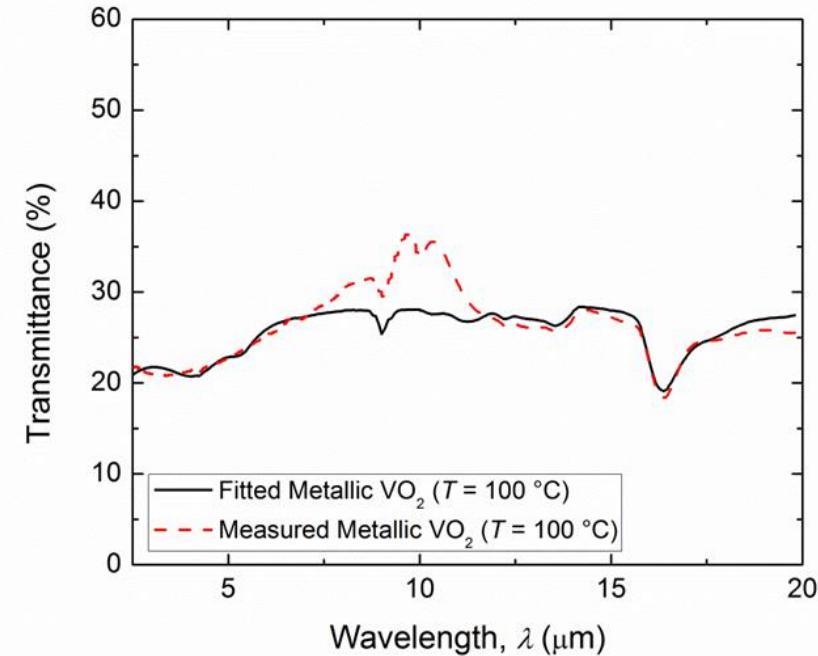
- Transmittance dips in fabricated films correspond to Si phonon modes
- All three fabricated VO₂ thin films had consistent transmittance
- Optical property models were developed for the VO₂ in IR range

Optical Property Fitting

Insulating VO₂ Lorentz Fit



Metallic VO₂ Dispersion Fit



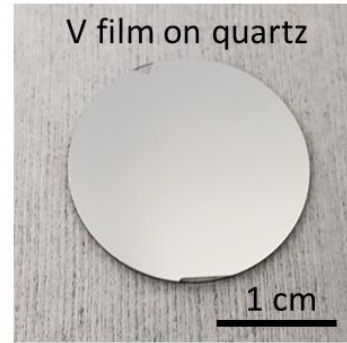
$$\varepsilon_d(\omega) = \varepsilon_\infty + \sum_{j=1}^N \frac{S_j \omega_j^2}{\omega_j^2 - i\gamma_j \omega - \omega^2}$$

Least Squares Fit:
$$F = \sum_{k=1}^N (T_{\text{exp}} - T_{\text{theo}})^2$$

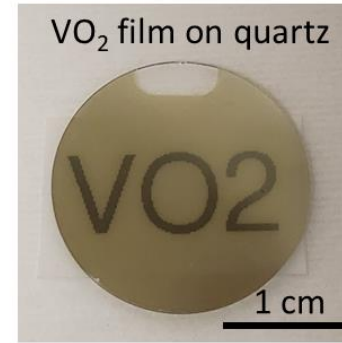
$$\varepsilon_m(\omega) = \varepsilon_\infty - \frac{\omega_n^2}{\omega^2 + i\omega_c \omega} + \sum_{j=1}^N \frac{S_j}{1 - \omega^2/\omega_j^2 - i\gamma_j \omega/\omega_j}$$

Ray Tracing:
$$T_{\text{theo}} = \frac{\tau_a \tau_s \tau}{1 - \rho_s \rho_b \tau^2}$$

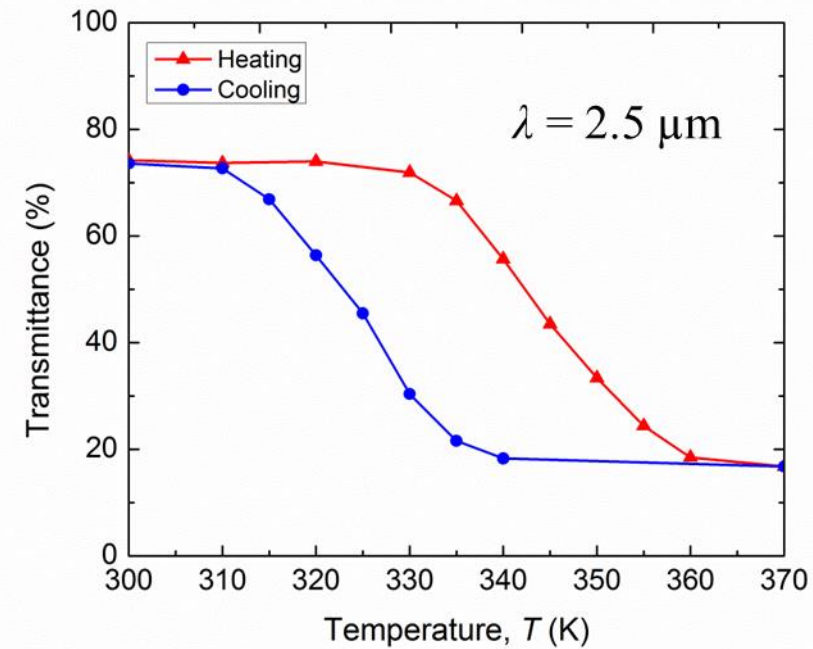
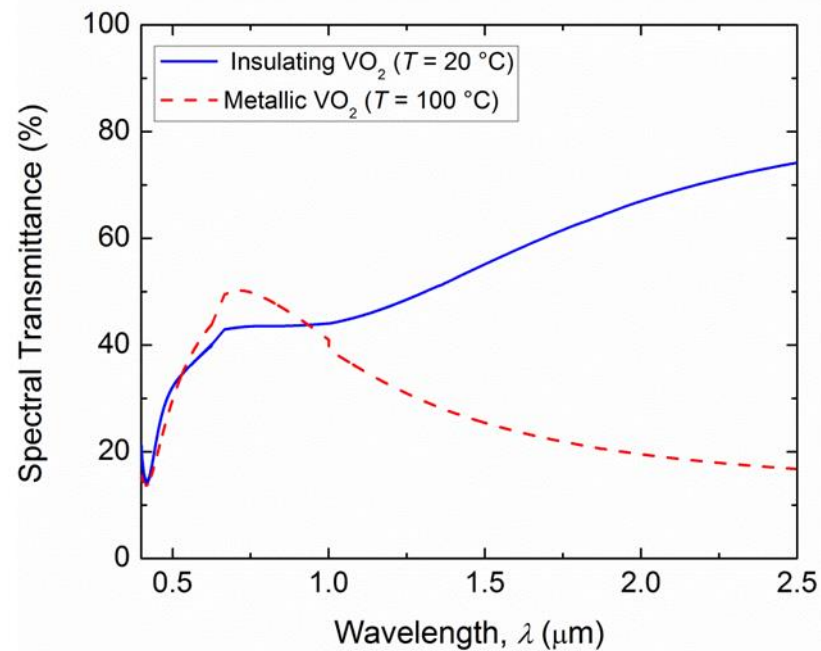
VO₂ VIS/NIR Characterization



Left: before oxidation

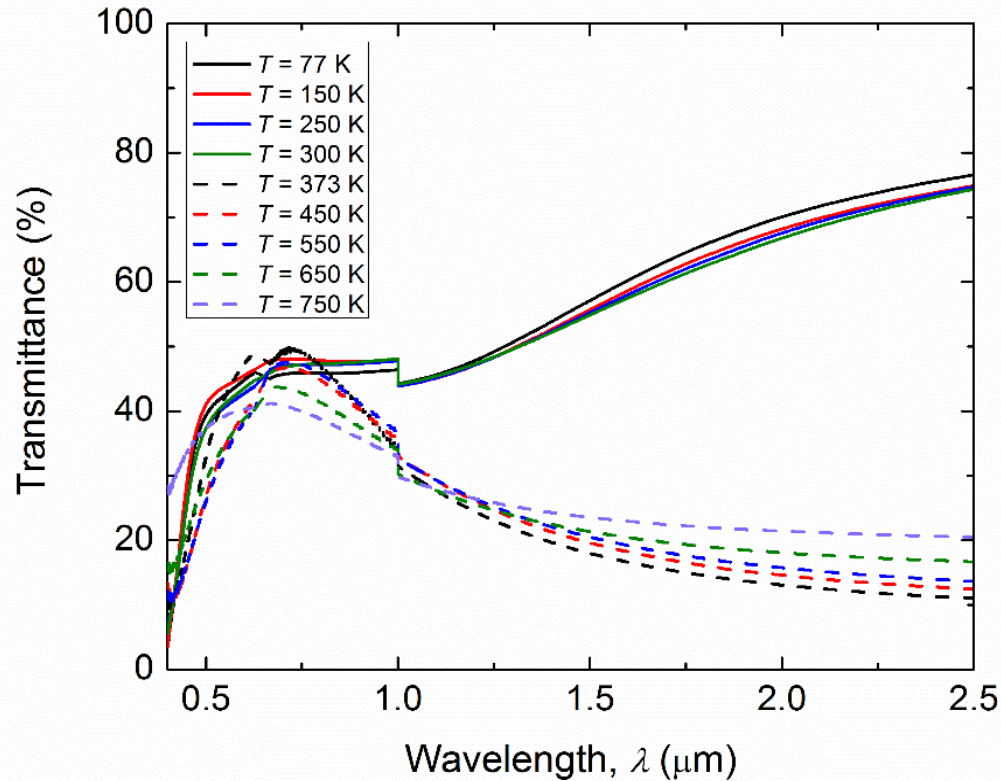


Right: after oxidation

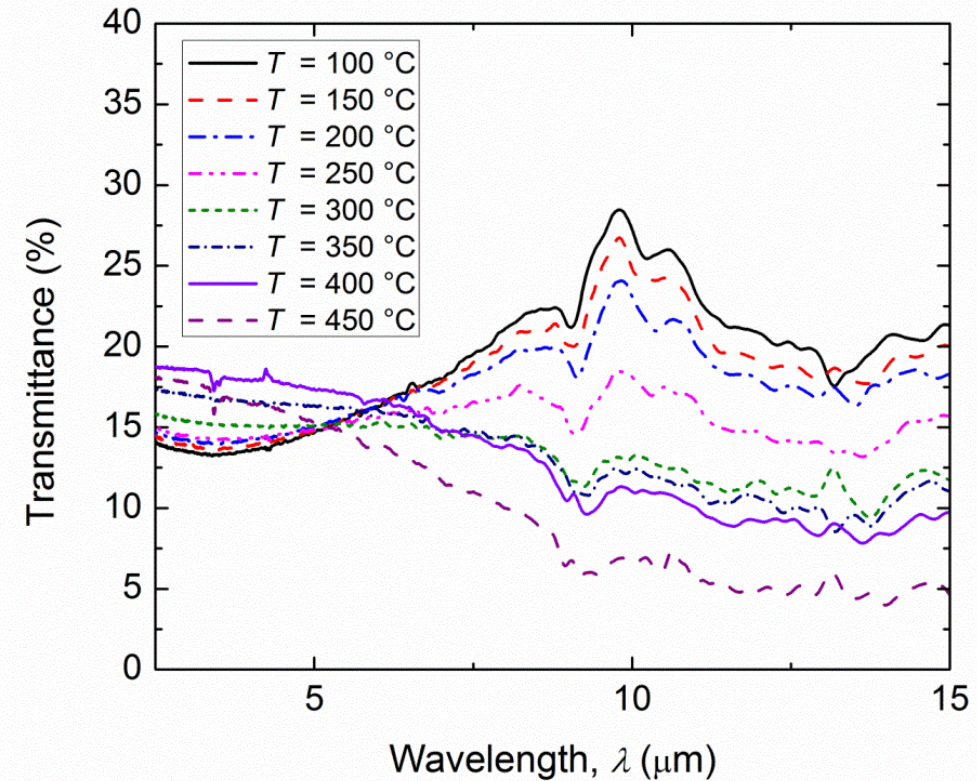


VO₂ Temperature Stability

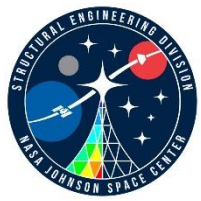
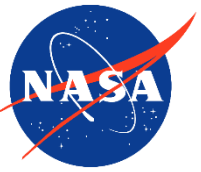
VIS/NIR (VO₂ on SiO₂)



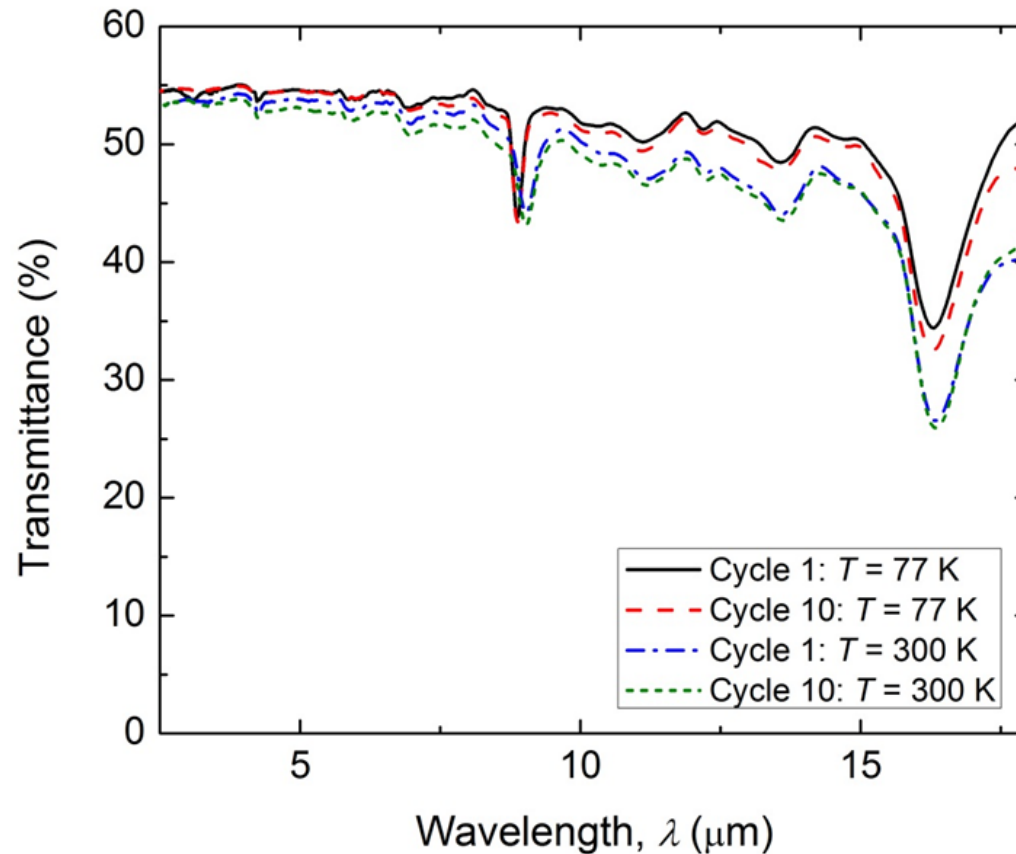
IR (VO₂ on Si)



- VO₂ is stable up until 200 °C
- VO₂ is not sensitive to cryogenic temperatures in the VIS/NIR range

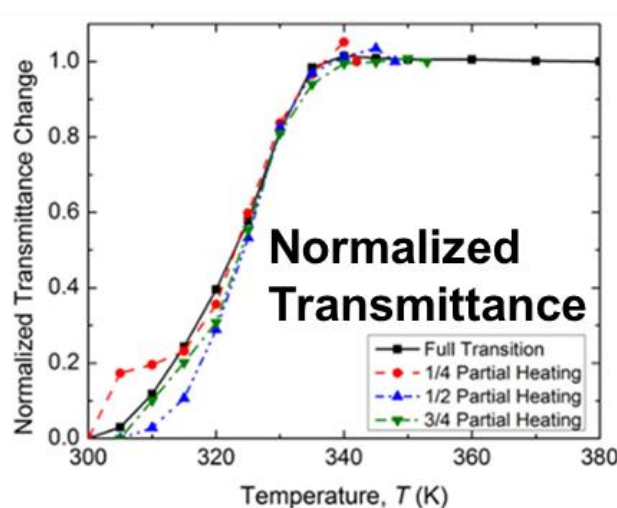
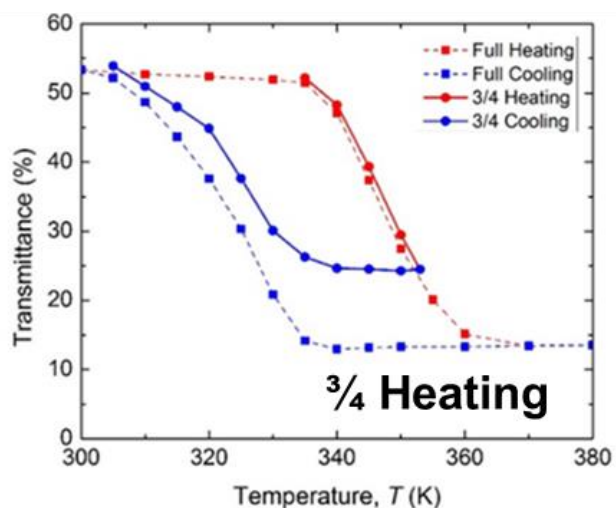
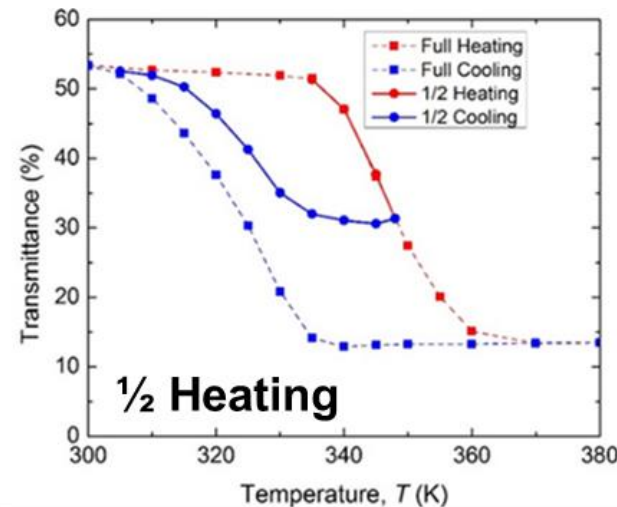
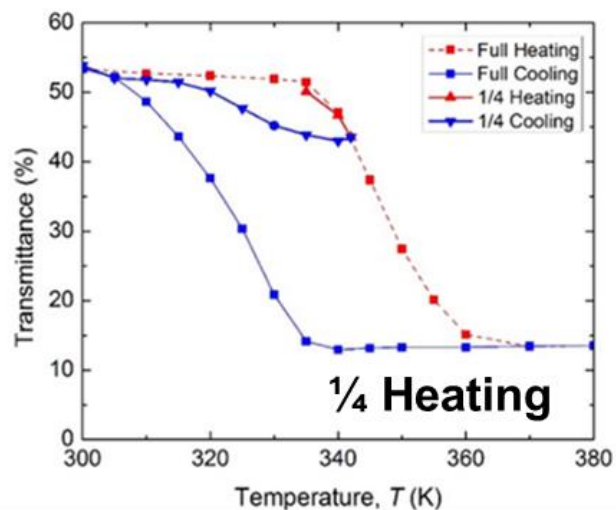


VO₂ Thermal Cycling Stability



- Thermochromic performance of VO₂ is not affected by cryogenic temperatures
- VO₂ did not degrade after being subjected to 10 thermal cycles

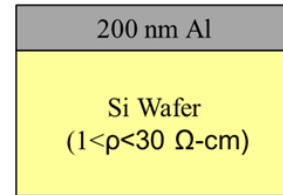
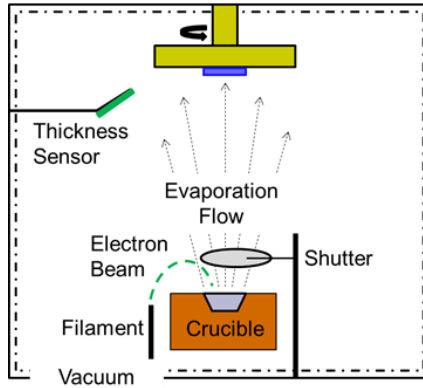
Partial Heating Hysteresis



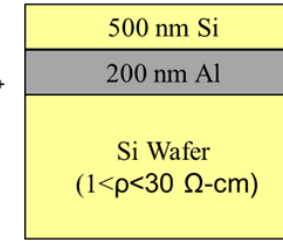
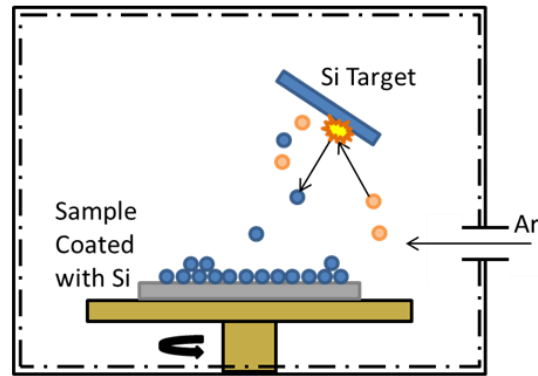
$$\lambda = 2.5 \mu\text{m}$$

VO₂ FP Emitter Fabrication

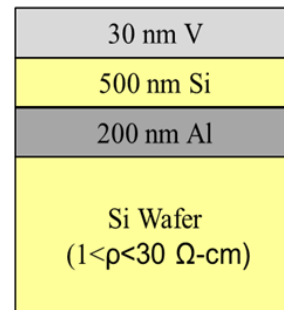
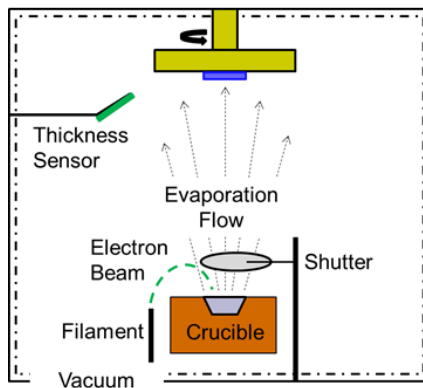
① 200 nm of Al with Electron Beam Evaporation (EBE)



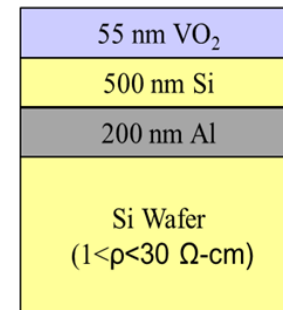
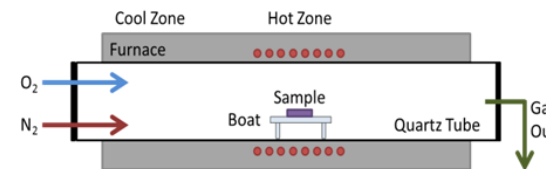
② 500 nm of Si with RF Magnetron Sputtering



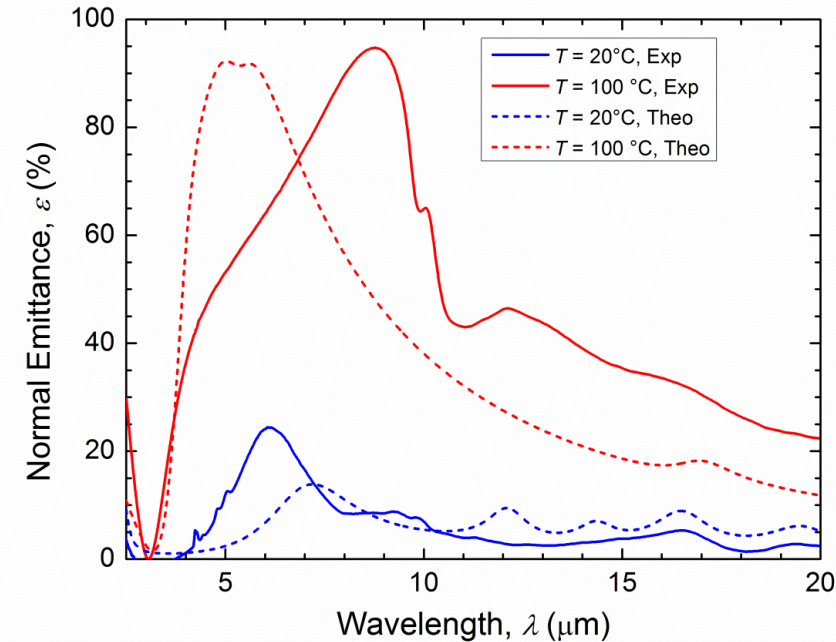
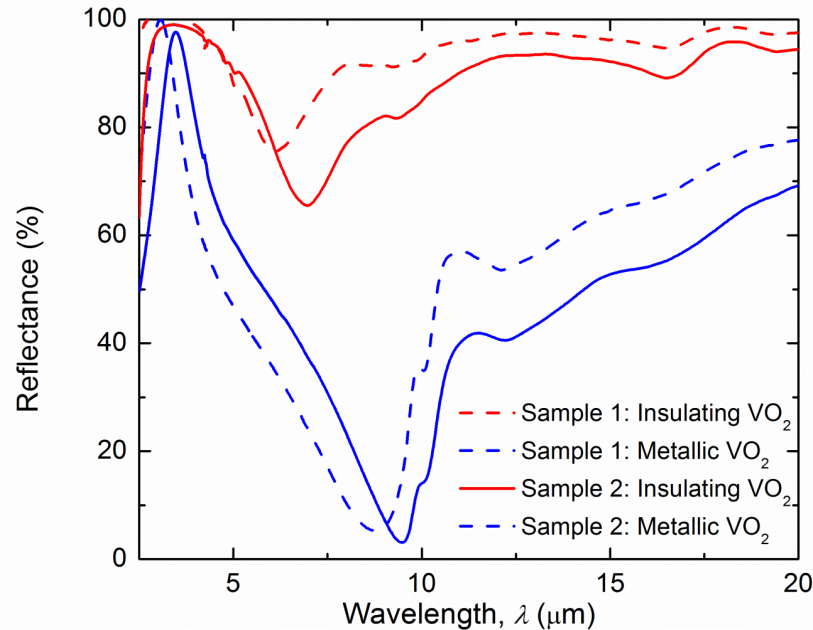
③ 30 nm of V with EBE



④ Oxidize in Tube Furnace



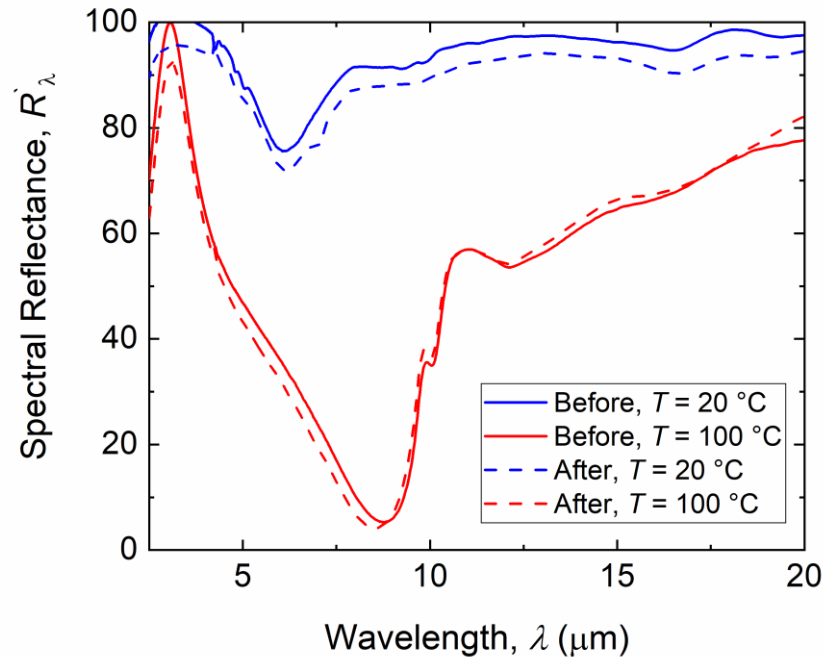
VO₂ FP Emitter Characterization



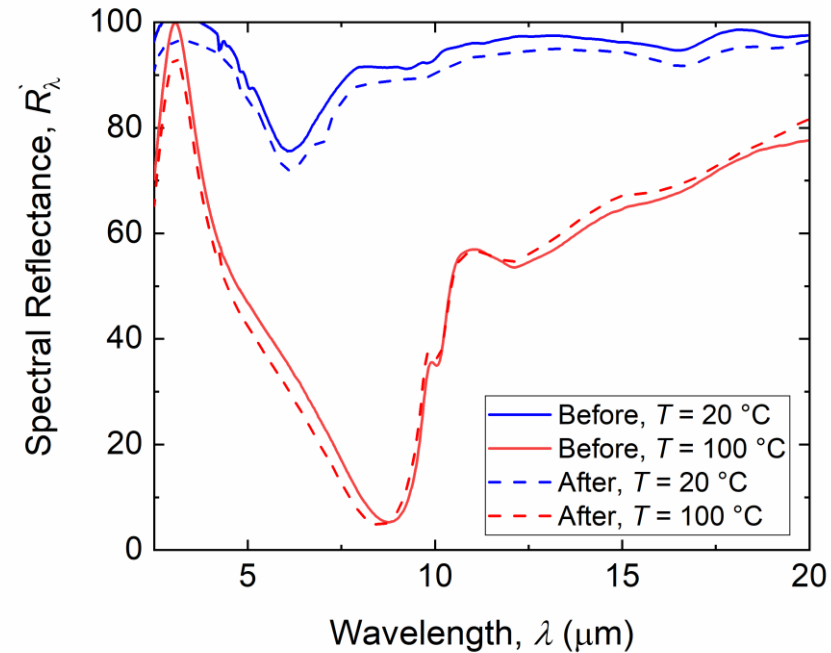
- Consistent behavior from both samples
- Significant change in mid-infrared reflectance upon phase transition
- Fabricated emitter demonstrates same behavior as the previously designed theoretical structure
- Disparity in experimental and theoretical performance could be explained by interface effects between VO₂ and Si, or by temperature-dependent optical properties for Si

FP Emitter Temperature Stability

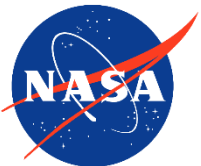
Cryogenic ($T = 77$ K) Stability



High Temp ($T = 200$ C) Stability

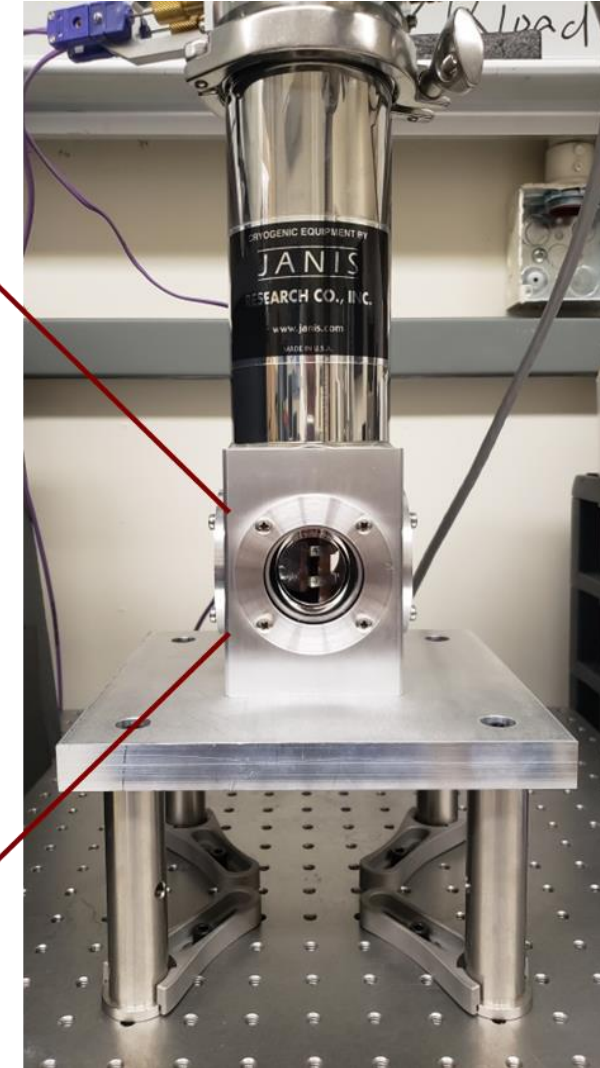
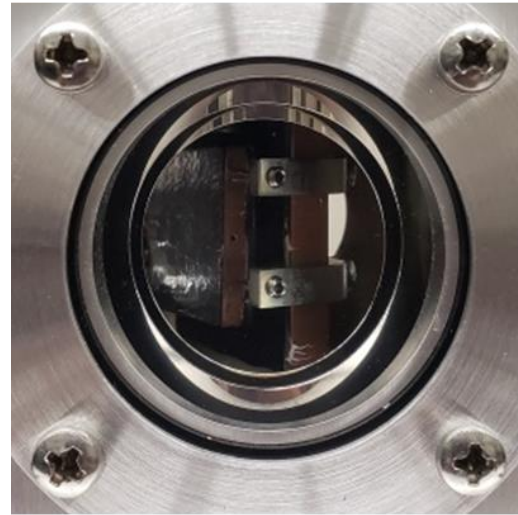
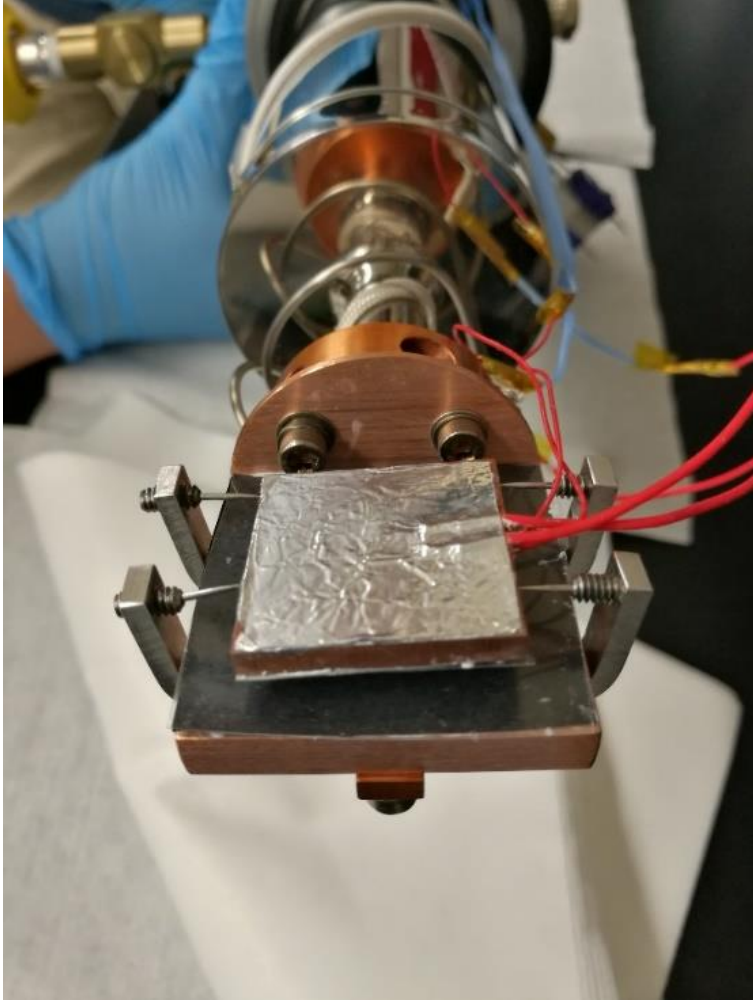


Before and after measurements for both samples are nearly identical, indicating good temperature stability for spacecraft thermal control applications



Thermal Vacuum Experiments and Feasibility Studies

Thermal Vacuum Experiment



Heat Transfer Model

$$\sum Q = 0 = Q_{heater} - Q_{rad} - \boxed{Q_{sides} - Q_{bot} - Q_{cond}}$$

Q_{loss}

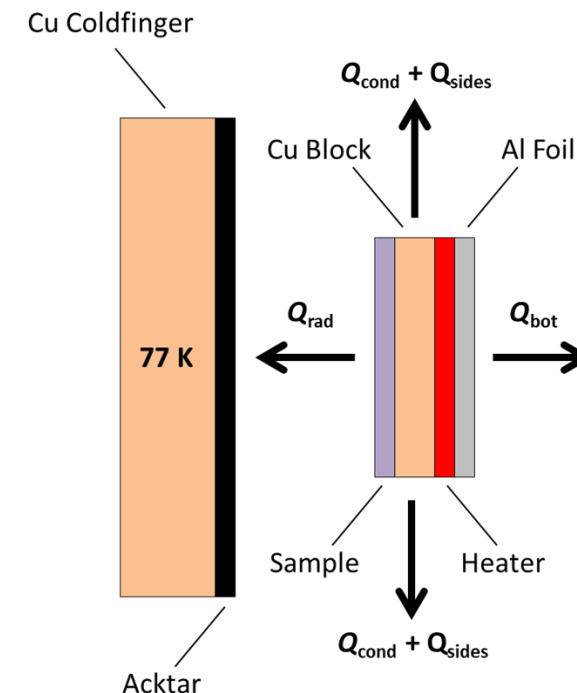
$$Q_{heater} = P_{heater} = I^2 R$$

$$Q_{emiss,theo} = \epsilon \sigma (T_{sample}^4 - T_{coldfinger}^4)$$

$$Q_{emiss,exp} = Q_{heater} - Q_{loss}$$

→ $Q_{loss}(T)$ is determined from the aluminum measurements:

$$\epsilon_{Al} = 0.03 \quad \rightarrow \quad Q_{loss}(T) = Q_{heater} - Q_{emiss,theo}$$

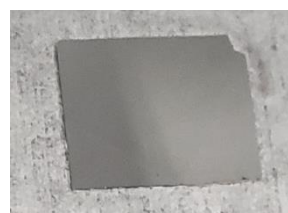


Black (Acktar)



$$\epsilon_{IR} \approx 93\%$$

Aluminum (200 nm on Si)



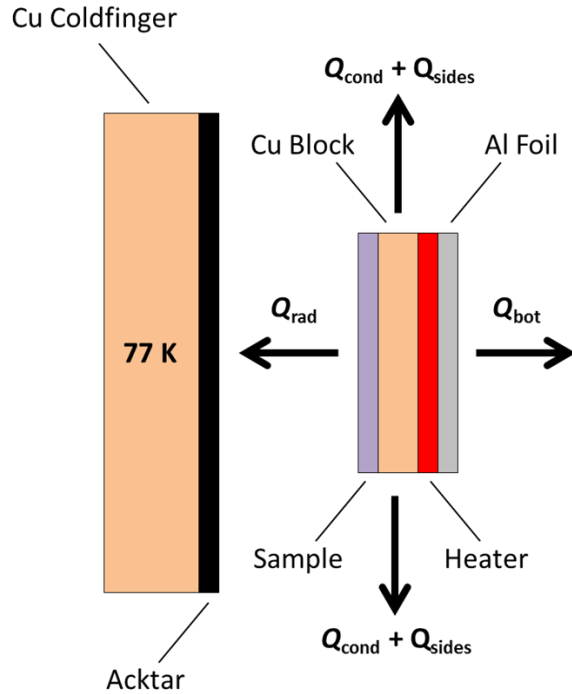
$$\epsilon_{IR} = 3\%$$

VO₂ FP Emitter



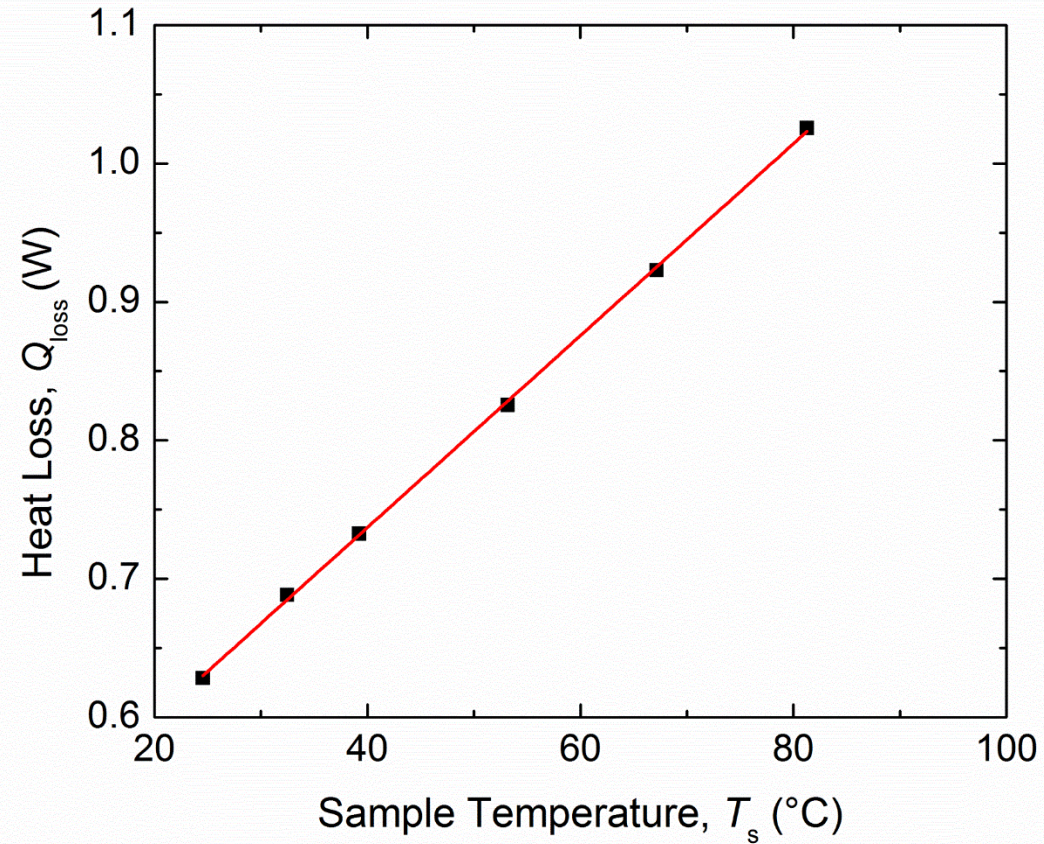
$$\epsilon_{IR} = \text{Varies with } T$$

Thermal Vacuum Experiment



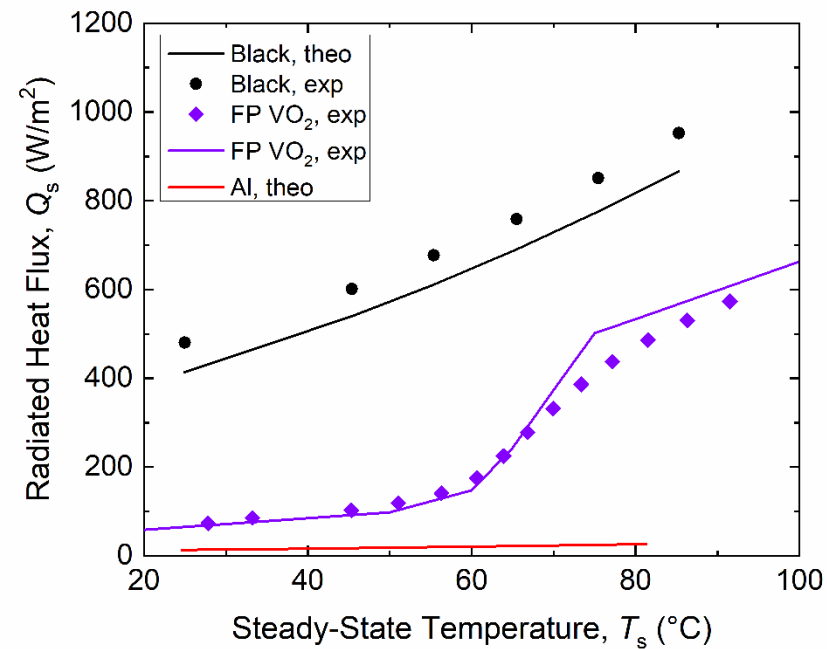
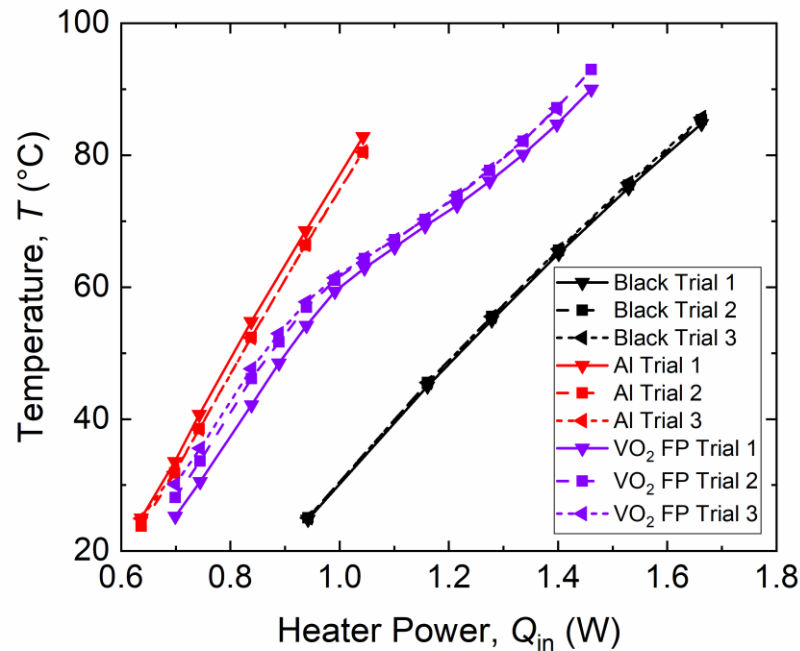
$$Q_{\text{loss}}(T) = Q_{\text{heater}} - Q_{\text{rad}}$$

$$Q_{\text{rad}} = \epsilon \sigma T_{\text{sample}}^4$$



- $Q_{\text{loss}}(T_s)$ is described by a linear fit
- Q_{loss} is independent of sample mounted

Thermal Vacuum Experiment

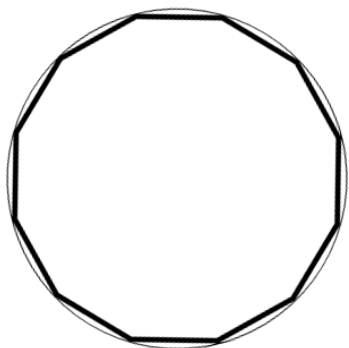


- Clear change in VO₂ FP behavior upon phase transition
- Good agreement between experiment and theoretical prediction
- VO₂ FP emitter varies heat from 72 W/m² at room temp to 570 W/m² at 90 °C



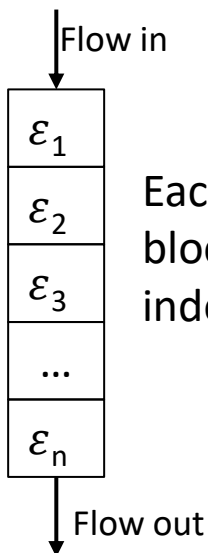
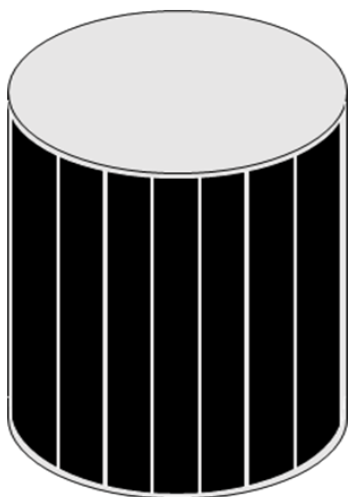
Spacecraft Thermal Systems Modeling

Top View

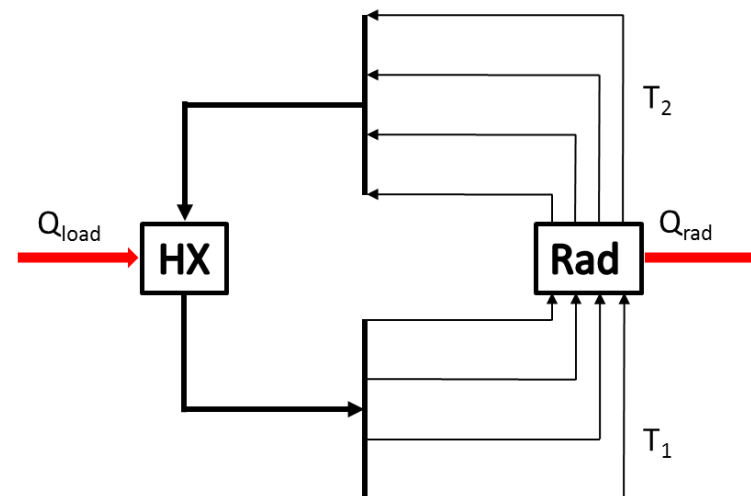


Body-mounted radiators that are discretized into $N = 360$ panels

Side View



Each panel is discretized into K blocks, each with their own independent emissivity

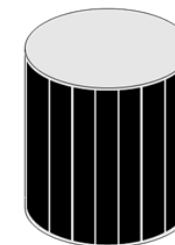
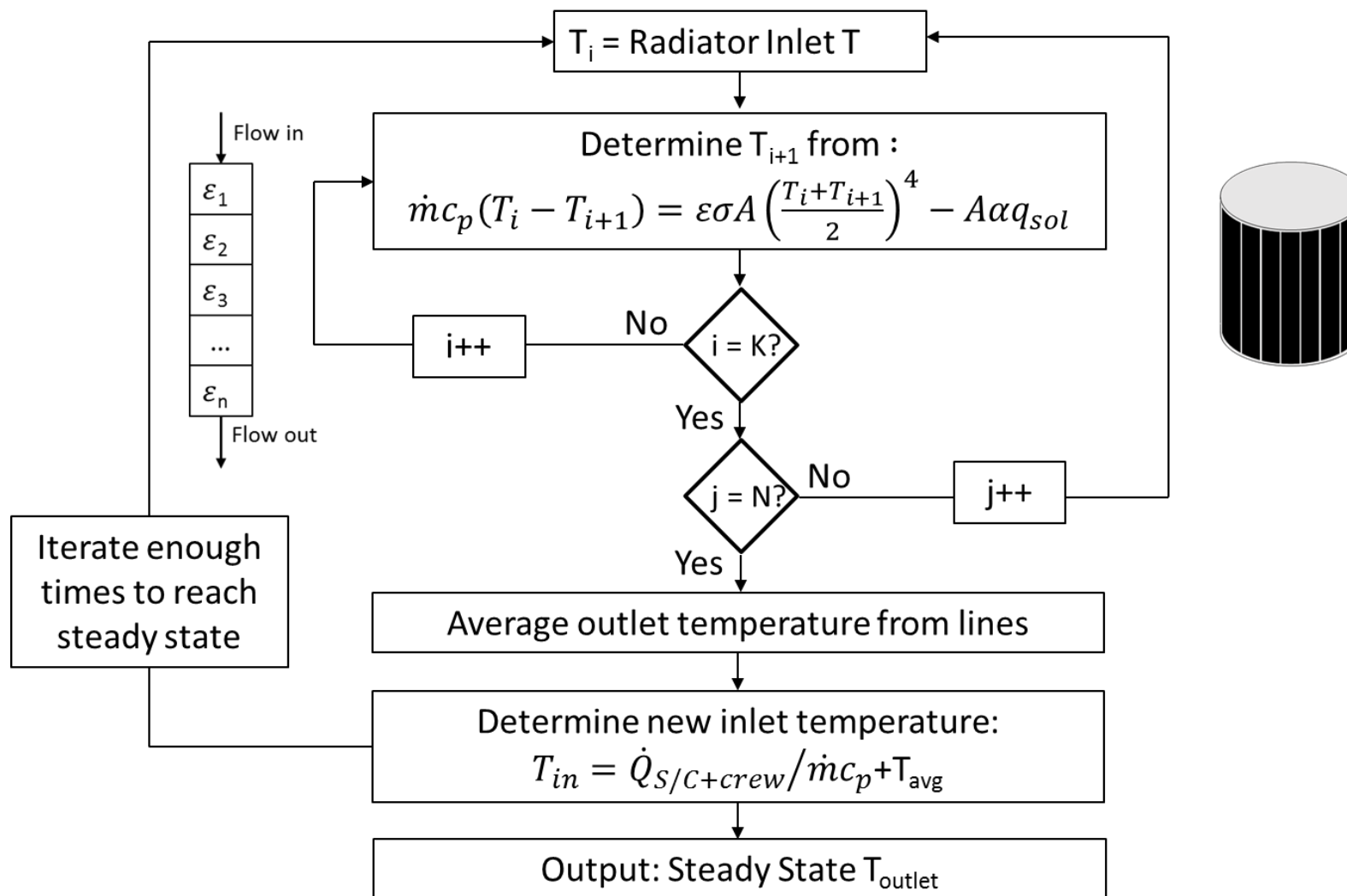


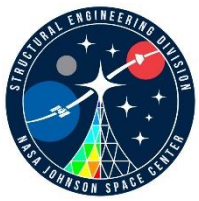
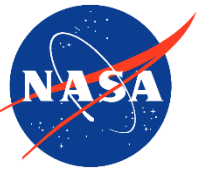
1. Fluid picks up heat from HX
2. Flow separates into 360 lines with equal flow rates
3. Heat is rejected by each separate fluid line/radiator panel
4. Flow is mixed to give average T_{outlet}

Objective: Determine Optimum Transition Temperature Range



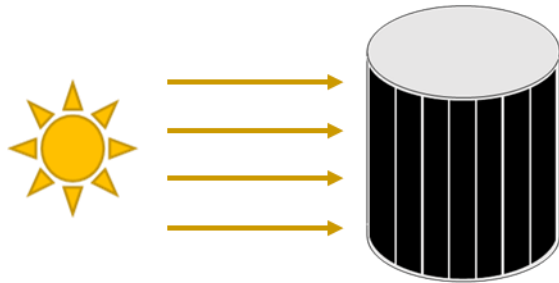
Coding Approach





Steady-State Cases Considered

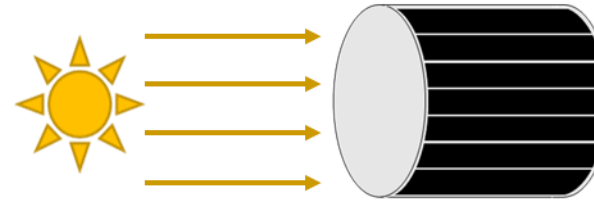
Hot Case



Full Heat Load

$$Q_{\text{FHL}} = 8500 \text{ W}$$

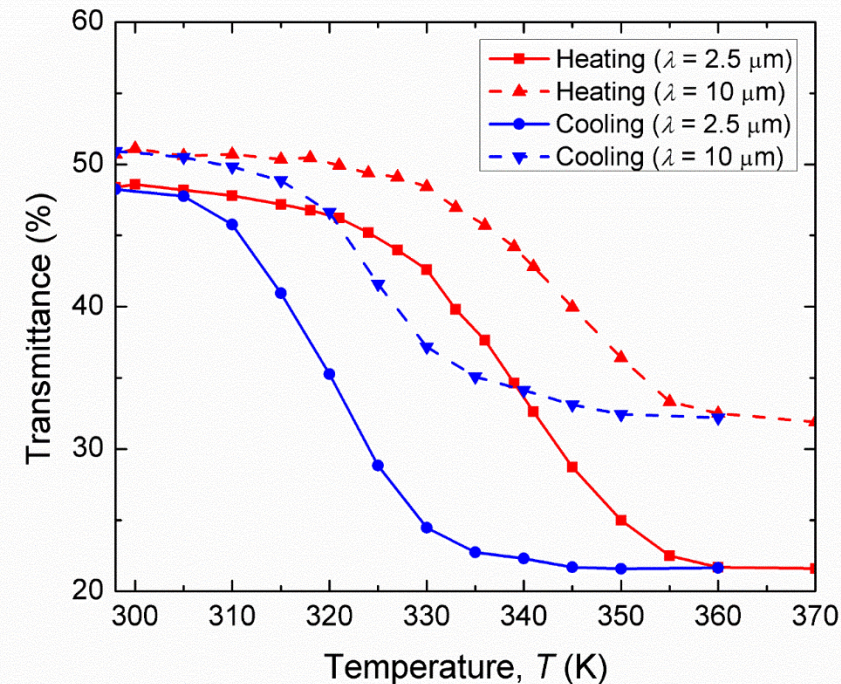
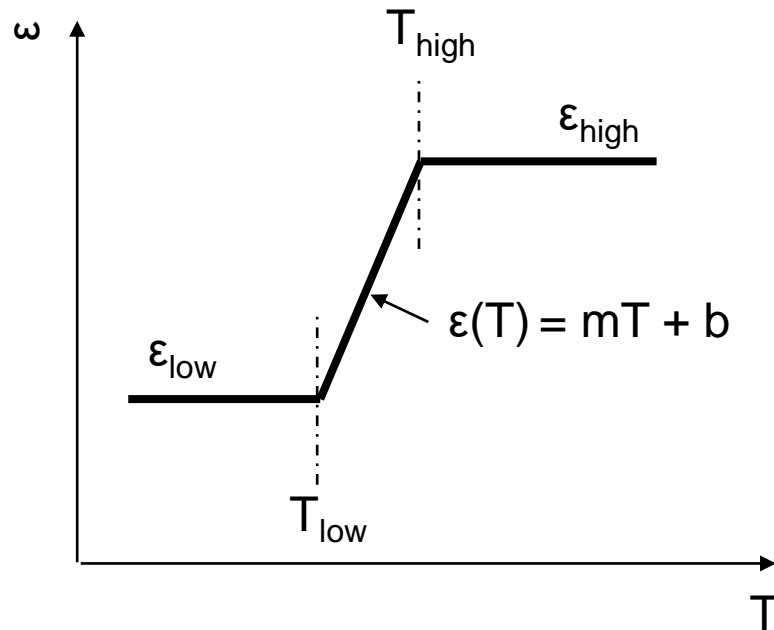
Cold Case



Partial Heat Load

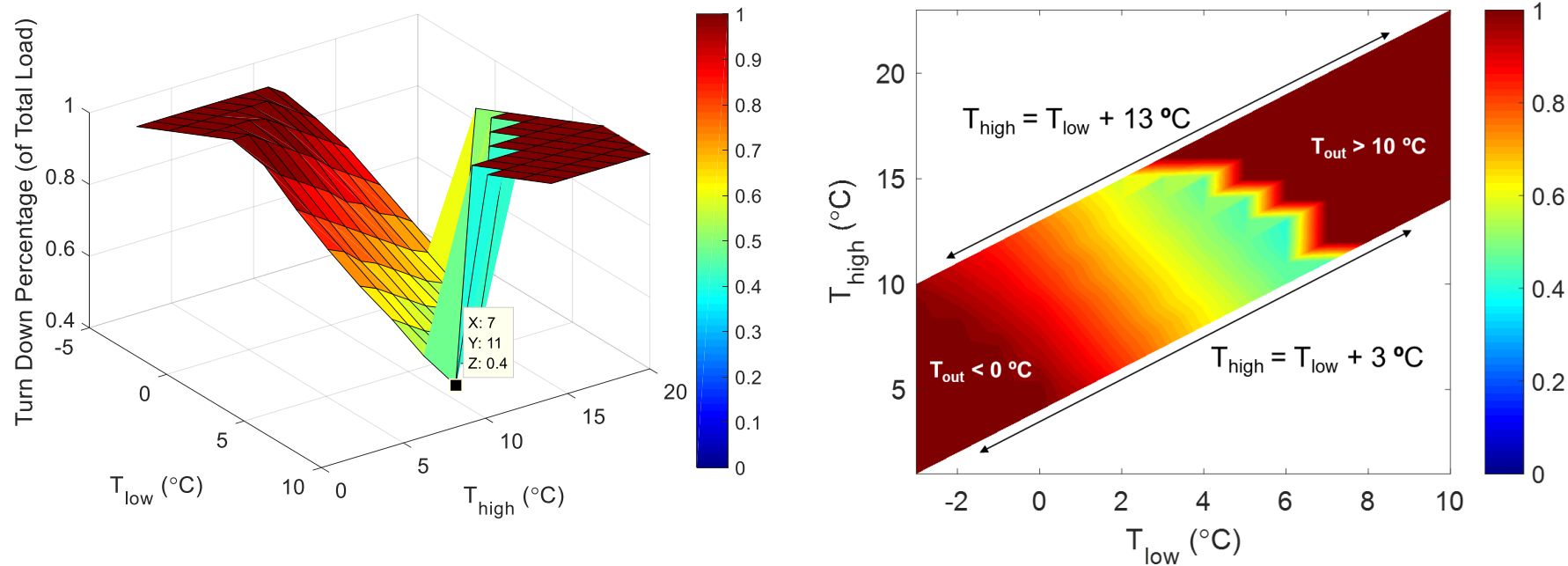
- Requirement 1: Average outlet temperature must be between 0 °C and 10 °C
- Requirement 2: The temperature of each radiator panel must be above -10 °C
- Turndown percentage TD = lowest percentage of full load that can be reduced to while still meeting requirements

Simplified VO₂ Variable Emittance



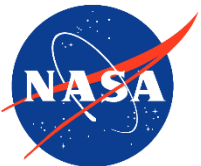
1. No hysteresis considered
 2. ϵ_{low} can vary between 0.3 and 0.6
 3. ϵ_{high} can vary between 0.6 and 0.9
 4. T_{high} must be between 4 and 20 degrees higher than T_{low}
- (2), (3), and (4) are based on fabrication limitations

Transition Range Optimization



Maximum turn down percentage of 40% occurs when $T_{low} = 7$ °C and $T_{high} = 11$ °C

- Optimization ends due to T_{out} going out of bounds
- No cases with freezing as the exit condition



On-going Projects at NASA



ASU VO₂ Variable Emittance



Tech Dev Project Objective:

Develop a thermochromic variable emittance coating based on W-doped VO₂ and a solar filtering layer

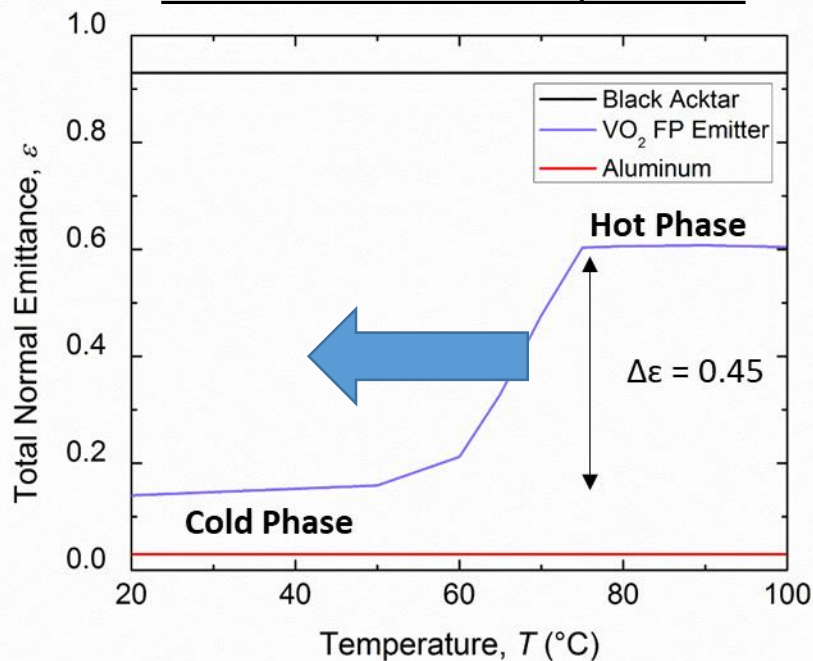
1-D PhC Solar Filter

Low n
High n
Low n
High n

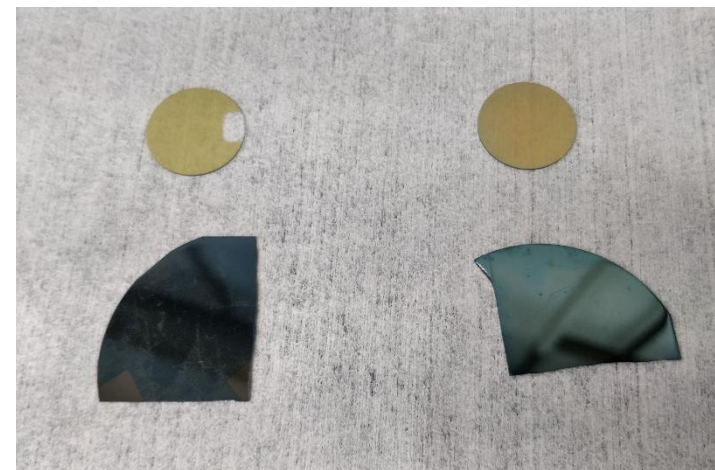
•
•
•

Low n
High n

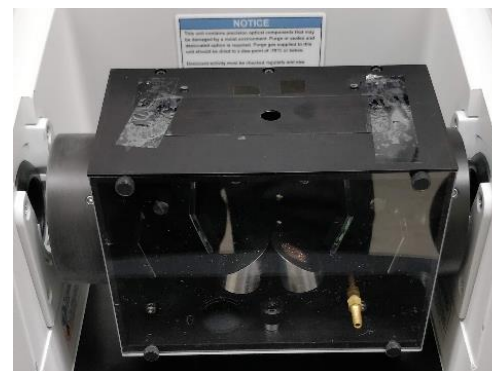
Shift Emittance Change to Lower Transition Temperature



First round of sputtered VO₂ thin film samples



Temperature-dependent Reflectance and Transmittance Measurements

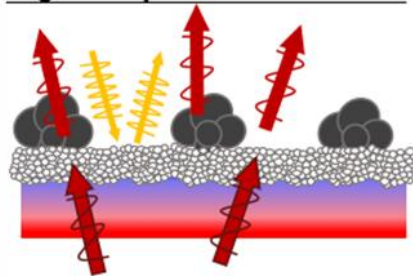


NSTGRO Project Objective:

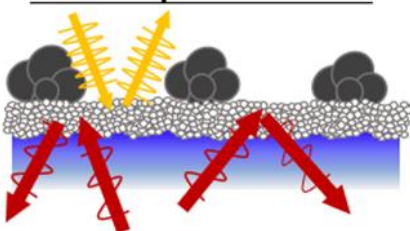
Develop a thermochromic variable emittance coating based on BaSO_4 white paint and LSM nanoparticles



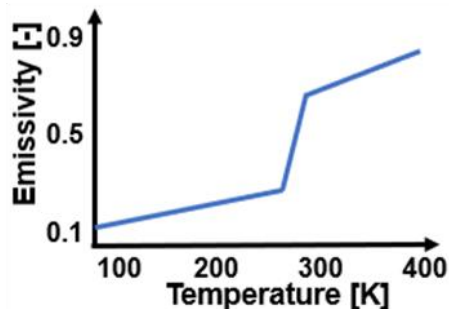
High Temp: Insulator Phase



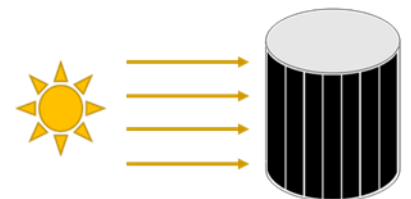
Low Temp: Metal Phase



= 0~3 μm Wavelength
 = 3~25 μm Wavelength
 ○ = BaSO_4 ● = LSM

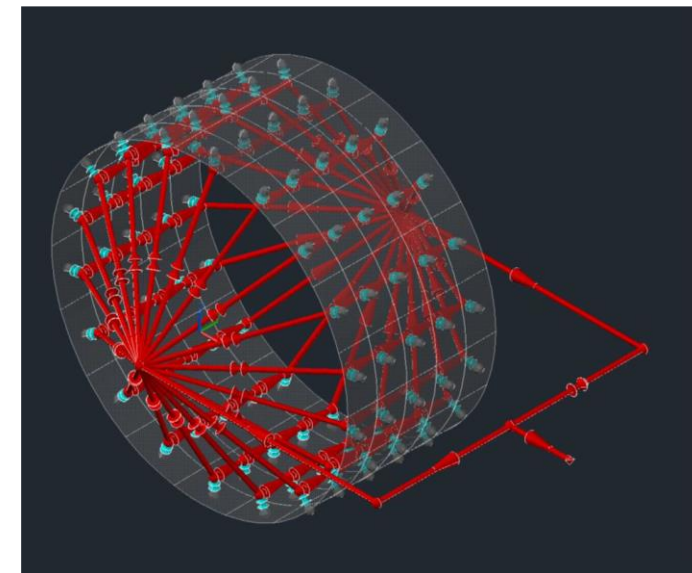
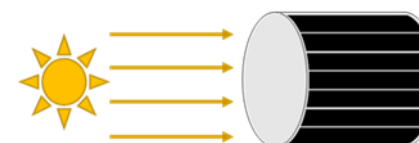


Hot Case



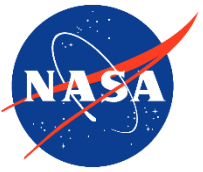
Full Heat Load

Cold Case

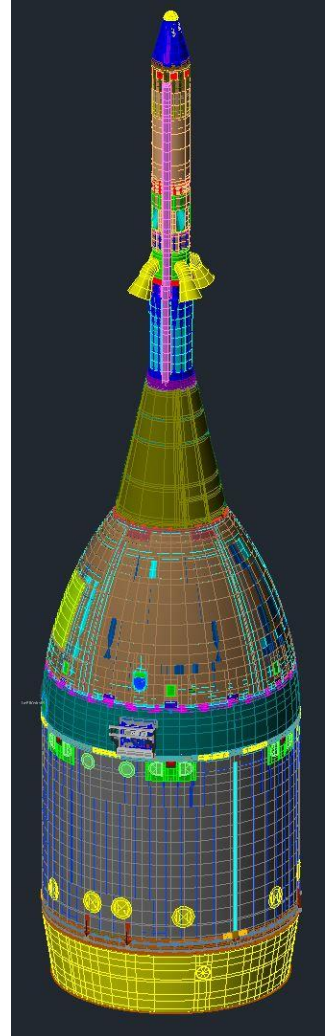
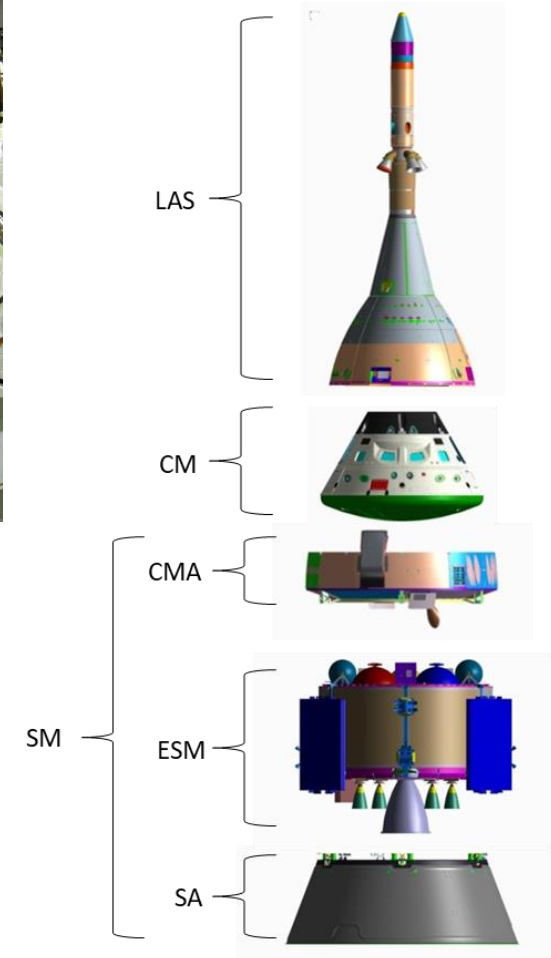
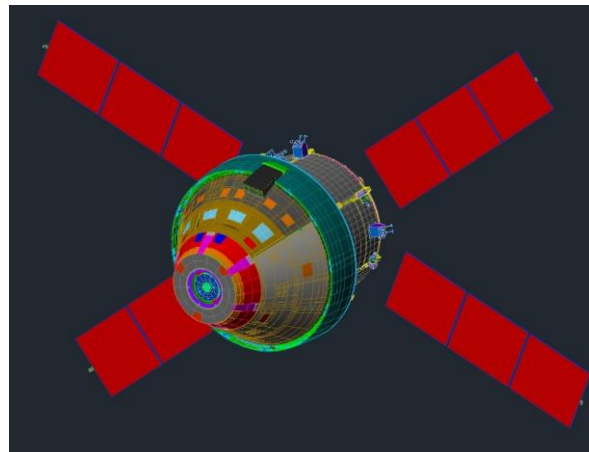
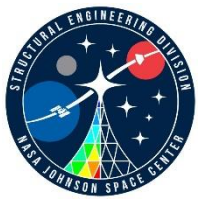


Variable Emittance Modeling Objective:

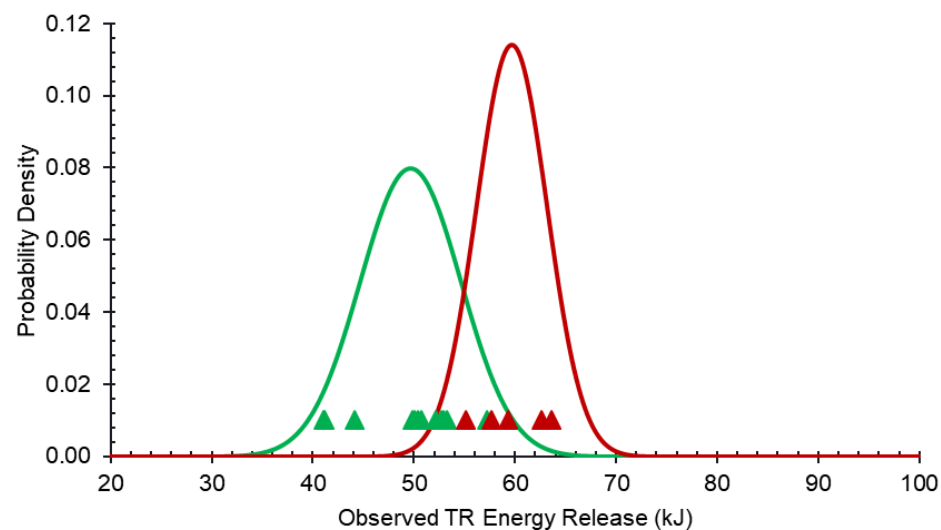
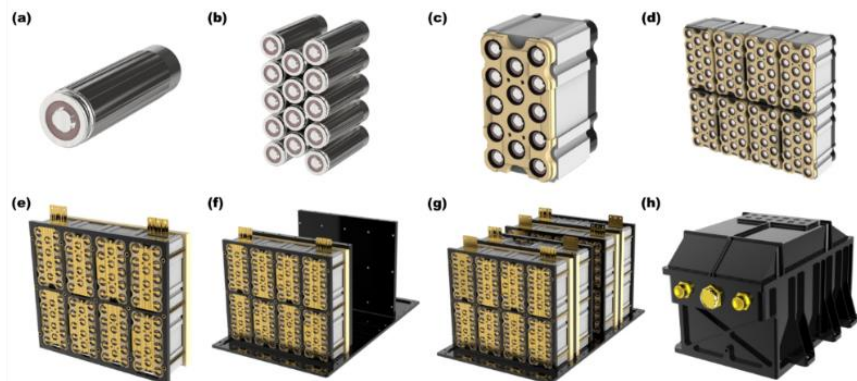
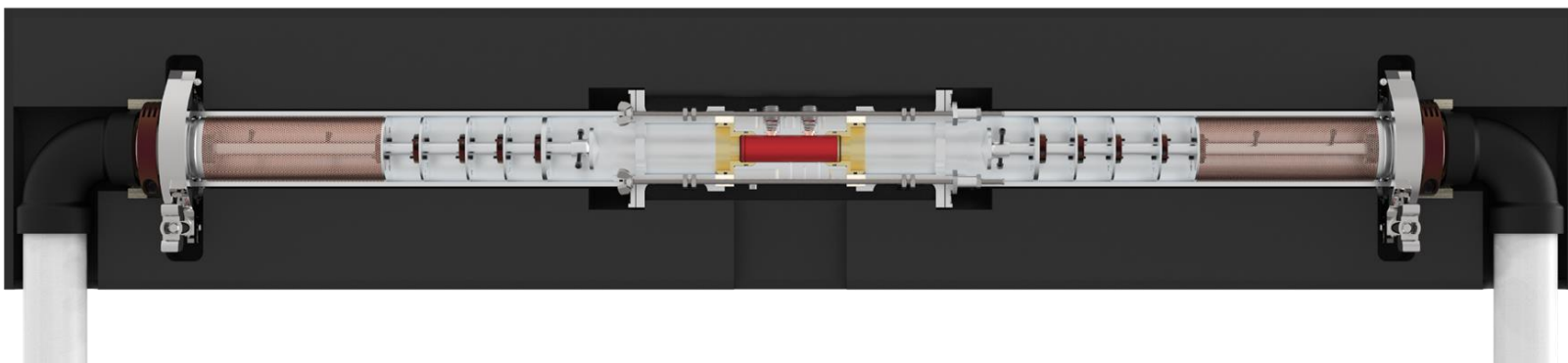
Determine transition temperature, emittance change, solar absorptance, etc. for the coating to be useful for spacecraft thermal control applications (both human and robotic)

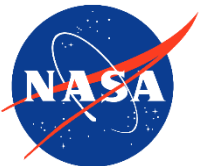


Orion Passive Thermal Control

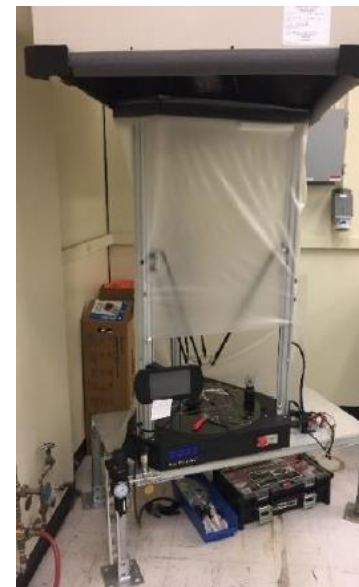
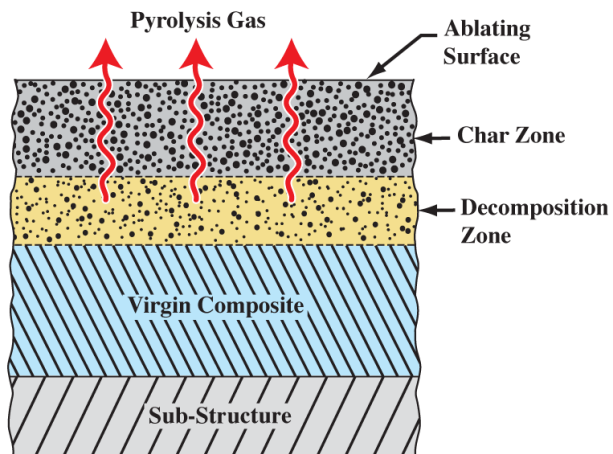
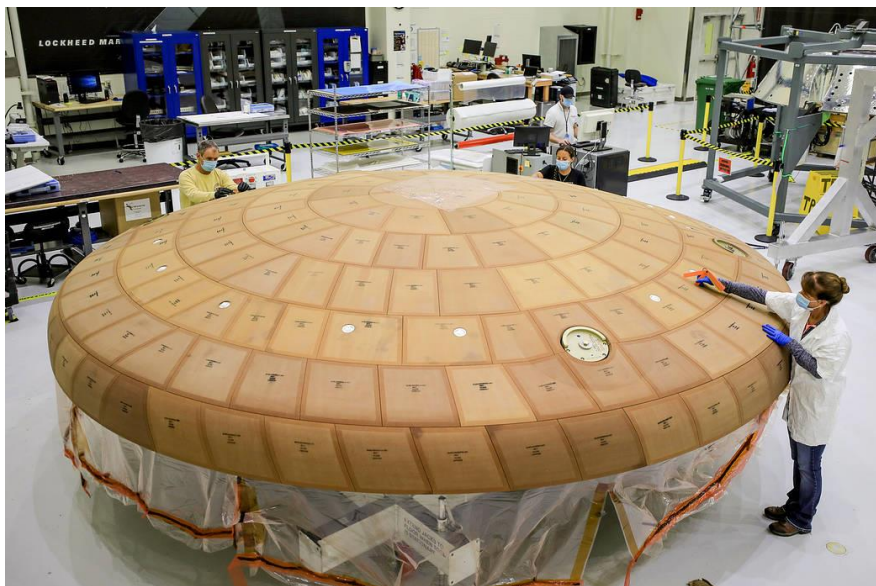


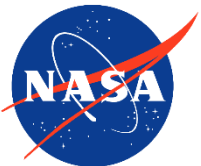
Battery Thermal Runaway Analysis and Testing





Orion and 3D Printed Thermal Protection Systems





Thermal Technology Gaps



2020 NASA Technology Taxonomy



→ Great resource for understanding what capabilities NASA has identified as necessary to complete our missions



Technology Areas:

- TX01: Propulsion Systems
- TX02: Flight Computing and Avionics
- TX03: Aerospace Power and Energy Storage
- TX04: Robotic Systems
- TX05: Communications, Navigation, and Orbital Debris Tracking and Characterization Systems
- TX06: Human Health, Life Support, and Habitation Systems
- TX07: Exploration Destination Systems
- TX08: Sensors and Instruments
- TX09: Entry, Descent, and Landing
- TX10: Autonomous Systems
- TX11: Software, Modeling, Simulation, and Information Processing
- TX12: Materials, Structures, Mechanical Systems, and Manufacturing
- TX13: Ground, Test, and Surface Systems
- TX14: Thermal Management Systems
- TX15: Flight Vehicle Systems
- TX16: Air Traffic Management and Range Tracking Systems
- TX17: Guidance, Navigation, and Control

TX14.2 Thermal Control Components and Systems

- **Thermal control phase change materials**
 - Need higher latent heat of fusion materials and PCM architectures that lead to high energy absorption per storage volume solutions on spacecraft.
- **High-performance, low contact pressure thermal interfaces**
 - Need thermal interfaces with predictable and repeatable interface conductances in different environments (lab versus spacecraft). Spacecraft application typically cannot apply high pressure.
- **High power density, long lifetime, space-qualified heater systems**
 - Need robust high watt density heaters, especially for non-planar surfaces.
- **Full-field, Full Structure Instrumentation**
 - Need instrumentation for stagnant fluid lines, high stress areas on structure, and high temperature structures.

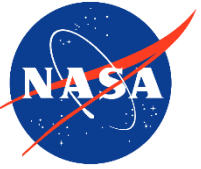




TX14.2 Thermal Control Components and Systems

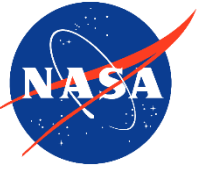
- **Fully-integrated Multiphysics modeling**
 - Need ability to simultaneously model thermal and mechanical behavior of spacecraft.
- **Dust Mitigation for thermal control surfaces**
 - Need a way to mitigate degradation of thermal control surfaces due to accumulation of dust.
- **Active/passive optical property control**
 - Need to tailor optical properties of thermal control coatings based on external environment or internal heat load.
- **Fully integrated thermal control systems**
 - Need to have thermal control components (heating elements, cold plates, heat pipes) embedded in structure.
- **High energy passive transport**
 - Need ability to move large amounts of heat to a needed location or heat rejection site.



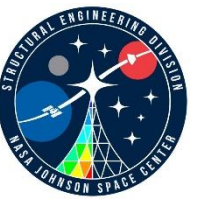


TX14.X Other Thermal Management Systems

- EDL flight vehicle (aeroshell) flight performance data for human Mars entry and Earth return
 - Need instrumentation to obtain flight vehicle performance data such as:
 - Pressure
 - Temperature
 - Heat flux
 - Radiation
 - Spectra from mid-IR to VUV
 - Strain
 - TPS recession/in-depth response
- Efficient, rapid processing of ultra-large thermal/fluid/propulsion databases
 - Need efficient, rapid processing of >100 Gb up to 1 Tb thermal/fluid/propulsion databases to enhance autonomous control



Questions?



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- NASA Space Technology Research Fellowship (NSTRF16)
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